

# TXB0108 8-Bit Bidirectional Voltage-Level Translator with Auto-Direction Sensing and $\pm 15\text{kV}$ ESD Protection

## 1 Features

- 1.2V to 3.6V on A Port and 1.65V to 5.5V on B Port ( $V_{CCA} \leq V_{CCB}$ )
- $V_{CC}$  Isolation Feature – If Either  $V_{CC}$  Input Is at GND, All Outputs Are in the High-Impedance State
- OE Input Circuit Referenced to  $V_{CCA}$
- Low Power Consumption,  $4\mu\text{A}$  Max  $I_{CC}$
- $I_{off}$  Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
  - A Port
    - 2000V Human-Body Model (A114-B)
    - 1000V Charged-Device Model (C101)
  - B Port
    - $\pm 15\text{kV}$  Human-Body Model (A114-B)
    - $\pm 8\text{kV}$  Human-Body Model (A114-B) (YZP Package Only)
    - 1000V Charged-Device Model (C101)

## 2 Applications

- Handset
- Smartphone
- Tablet
- Desktop PC

## 3 Description

This 8-bit noninverting translator uses two separate configurable power-supply rails. The A port is designed to track  $V_{CCA}$ .  $V_{CCA}$  accepts any supply voltage from 1.2V to 3.6V. The B port is designed to track  $V_{CCB}$ .  $V_{CCB}$  accepts any supply voltage from 1.65V to 5.5V. This allows for universal low-voltage

bidirectional translation between any of the 1.2V, 1.5V, 1.8V, 2.5V, 3.3V, and 5V voltage nodes.  $V_{CCA}$  should not exceed  $V_{CCB}$ .

When the output-enable (OE) input is low, all outputs are placed in the high-impedance state.

The TXB0108 is designed so that the OE input circuit is supplied by  $V_{CCA}$ .

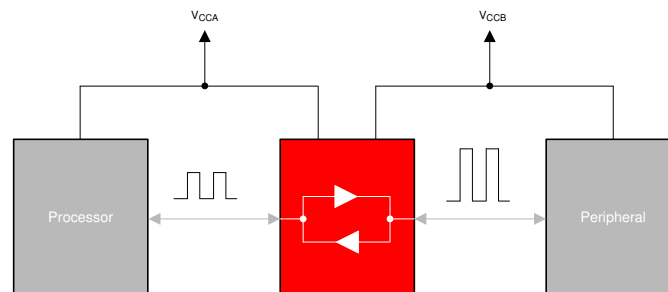
This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

To ensure the high-impedance state during power-up or power-down, OE should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

### Device Information

| PART NUMBER | PACKAGE <sup>(1)</sup>    | BODY SIZE (NOM) |
|-------------|---------------------------|-----------------|
| TXB0108DQS  | SON (20)                  | 2.00mm x 4.00mm |
| TXB0108ZXY  | BGA MICROSTAR JUNIOR (20) | 2.50mm x 3.00mm |
| TXB0108PW   | TSSOP (20)                | 6.50mm x 4.40mm |
| TXB0108RGY  | VQFN (20)                 | 4.50mm x 3.50mm |
| TXB0108YZP  | DSGBA (20)                | 1.90mm x 2.40mm |
| TXB0108NME  | nFBGA (20)                | 2.50mm x 3.00mm |
| TXB0108RUK  | WQFN (20)                 | 3.00mm x 3.00mm |
| TXB0108DGS  | VSSOP (20)                | 5.10mm x 3.00mm |
| TXB0108RKS  | VQFN (20)                 | 4.50mm x 2.50mm |

(1) For all available packages, see the orderable addendum at the end of the datasheet.



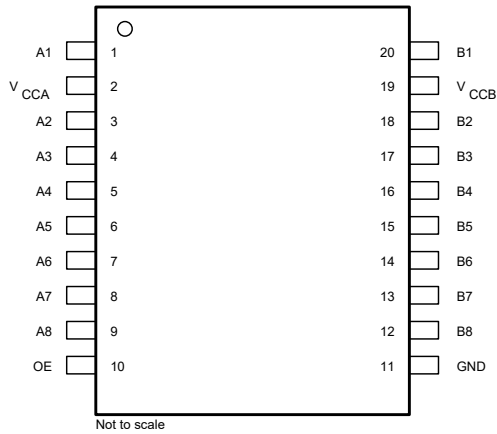
**Typical Application Block Diagram for TXB0108**



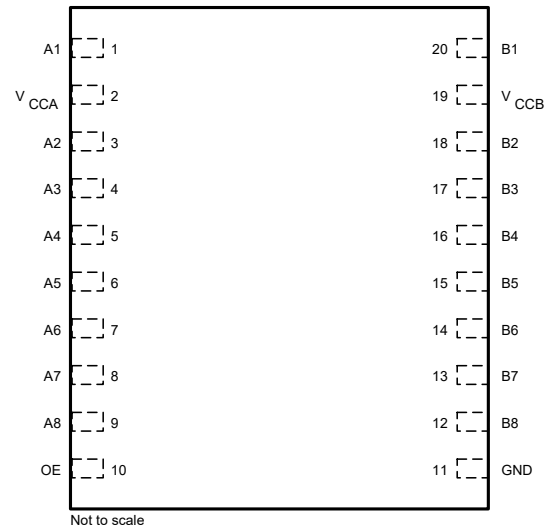
## Table of Contents

|                                                                                     |           |                                                                                    |           |
|-------------------------------------------------------------------------------------|-----------|------------------------------------------------------------------------------------|-----------|
| <b>1 Features</b> .....                                                             | <b>1</b>  | 5.19 Switching Characteristics: $V_{CCA} = 2.5V \pm 0.2V$<br>(Other Packages)..... | <b>12</b> |
| <b>2 Applications</b> .....                                                         | <b>1</b>  | 5.20 Switching Characteristics: $V_{CCA} = 3.3V \pm 0.3V$<br>(DGS/RUK/RKS).....    | <b>12</b> |
| <b>3 Description</b> .....                                                          | <b>1</b>  | 5.21 Switching Characteristics: $V_{CCA} = 3.3V \pm 0.3V$<br>(Other Packages)..... | <b>13</b> |
| <b>4 Pin Configuration and Functions</b> .....                                      | <b>3</b>  | 5.22 Operating Characteristics.....                                                | <b>13</b> |
| <b>5 Specifications</b> .....                                                       | <b>6</b>  | 5.23 Typical Characteristics.....                                                  | <b>14</b> |
| 5.1 Absolute Maximum.....                                                           | <b>6</b>  | <b>6 Parameter Measurement Information</b> .....                                   | <b>15</b> |
| 5.2 Handling Ratings.....                                                           | <b>6</b>  | <b>7 Detailed Description</b> .....                                                | <b>16</b> |
| 5.3 Recommended Operating Conditions.....                                           | <b>6</b>  | 7.1 Overview.....                                                                  | <b>16</b> |
| 5.4 Thermal Information.....                                                        | <b>7</b>  | 7.2 Functional Block Diagram.....                                                  | <b>16</b> |
| 5.5 Electrical Characteristics (DGS/RUK/RKS).....                                   | <b>7</b>  | 7.3 Feature Description.....                                                       | <b>17</b> |
| 5.6 Electrical Characteristics (Other Packages).....                                | <b>8</b>  | 7.4 Device Functional Modes.....                                                   | <b>18</b> |
| 5.7 Timing Requirements: $V_{CCA} = 1.2V$ .....                                     | <b>9</b>  | <b>8 Application and Implementation</b> .....                                      | <b>19</b> |
| 5.8 Timing Requirements: $V_{CCA} = 1.5V \pm 0.1V$ .....                            | <b>9</b>  | 8.1 Application Information.....                                                   | <b>19</b> |
| 5.9 Timing Requirements: $V_{CCA} = 1.8V \pm 0.15V$ .....                           | <b>9</b>  | 8.2 Typical Application.....                                                       | <b>19</b> |
| 5.10 Timing Requirements: $V_{CCA} = 2.5V \pm 0.2V$ .....                           | <b>9</b>  | <b>9 Power Supply Recommendations</b> .....                                        | <b>21</b> |
| 5.11 Timing Requirements: $V_{CCA} = 3.3V \pm 0.3V$ .....                           | <b>9</b>  | <b>10 Layout</b> .....                                                             | <b>21</b> |
| 5.12 Switching Characteristics: $V_{CCA} = 1.2V$<br>(DGS/RUK/RKS).....              | <b>9</b>  | 10.1 Layout Guidelines.....                                                        | <b>21</b> |
| 5.13 Switching Characteristics: $V_{CCA} = 1.2V$ (Other<br>Packages).....           | <b>10</b> | 10.2 Layout Example.....                                                           | <b>21</b> |
| 5.14 Switching Characteristics: $V_{CCA} = 1.5V \pm 0.1V$<br>(DGS/RUK/RKS).....     | <b>10</b> | <b>11 Device and Documentation Support</b> .....                                   | <b>22</b> |
| 5.15 Switching Characteristics: $V_{CCA} = 1.5V \pm 0.1V$<br>(Other Packages).....  | <b>11</b> | 11.1 Receiving Notification of Documentation Updates..                             | <b>22</b> |
| 5.16 Switching Characteristics: $V_{CCA} = 1.8V \pm 0.15V$<br>(DGS/RUK/RKS).....    | <b>11</b> | 11.2 Support Resources.....                                                        | <b>22</b> |
| 5.17 Switching Characteristics: $V_{CCA} = 1.8V \pm 0.15V$<br>(Other Packages)..... | <b>11</b> | 11.3 Trademarks.....                                                               | <b>22</b> |
| 5.18 Switching Characteristics: $V_{CCA} = 2.5V \pm 0.2V$<br>(DGS/RUK/RKS).....     | <b>12</b> | 11.4 Electrostatic Discharge Caution.....                                          | <b>22</b> |
|                                                                                     |           | 11.5 Glossary.....                                                                 | <b>22</b> |
|                                                                                     |           | <b>12 Revision History</b> .....                                                   | <b>22</b> |
|                                                                                     |           | <b>13 Mechanical, Packaging, and Orderable<br/>Information</b> .....               | <b>23</b> |

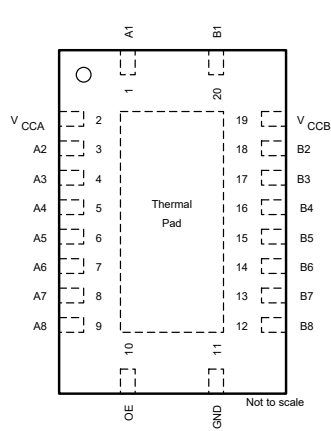
## 4 Pin Configuration and Functions



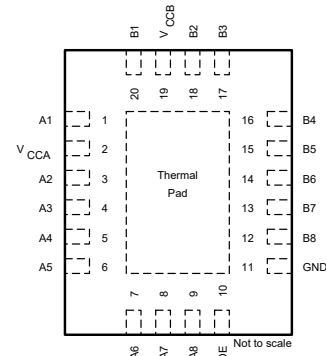
**Figure 4-1. DGS/PW Package (Top View)**



**Figure 4-2. DQS Package (Top View)**

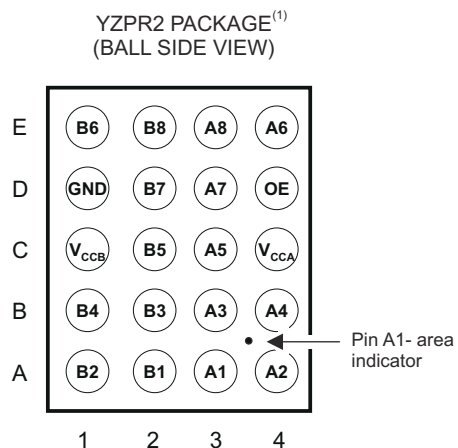


**Figure 4-3. RGY/RKS Package (Top View)**

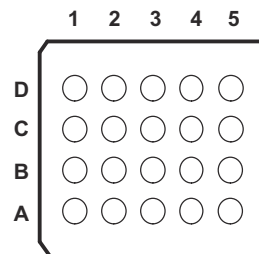


**Figure 4-4. RUK Package (Top View)**

- For the RKS/RGY/RUK package, the exposed center thermal pad must be connected to ground.
- Pullup resistors are not required on both sides for Logic I/O.
- If pullup or pulldown resistors are needed, the resistor value must be over 50kΩ.
- 50kΩ is a safe recommended value, if the customer can accept higher  $V_{OL}$  or lower  $V_{OH}$ , smaller pullup or pulldown resistor is allowed, the draft estimation is  $V_{OL} = V_{CCOUT} \times 4.5k / (4.5k + R_{PU})$  and  $V_{OH} = V_{CCOUT} \times R_{DW} / (4.5k + R_{DW})$ .
- If pullup resistors are needed, please refer to the TXS0108 or contact TI.
- For detailed information, please refer [A Guide to Voltage Translation With TXB-Type Translators](#).



<sup>(1)</sup> See orderable addendum at the end of the data sheet



**Figure 4-5. NME/GXY/ZXY PACKAGE (BOTTOM VIEW)**

**Table 4-1. Pin Functions**

| PIN         |             |         |                  | I/O <sup>(1)</sup> | FUNCTION                                                                                        |
|-------------|-------------|---------|------------------|--------------------|-------------------------------------------------------------------------------------------------|
| SIGNAL NAME | PW, RGY NO. | DQS NO. | YZP GRID LOCATOR |                    |                                                                                                 |
| A1          | 1           | 1       | A3               | I/O                | Input/output 1. Referenced to $V_{CCA}$ .                                                       |
| $V_{CCA}$   | 2           | 5       | C4               | S                  | A-port supply voltage. $1.1\text{ V} \leq V_{CCA} \leq 3.6\text{ V}$ , $V_{CCA} \leq V_{CCB}$ . |
| A2          | 3           | 2       | A4               | I/O                | Input/output 2. Referenced to $V_{CCA}$ .                                                       |
| A3          | 4           | 3       | B3               | I/O                | Input/output 3. Referenced to $V_{CCA}$ .                                                       |
| A4          | 5           | 4       | B4               | I/O                | Input/output 4. Referenced to $V_{CCA}$ .                                                       |
| A5          | 6           | 7       | C3               | I/O                | Input/output 5. Referenced to $V_{CCA}$ .                                                       |
| A6          | 7           | 8       | E4               | I/O                | Input/output 6. Referenced to $V_{CCA}$ .                                                       |
| A7          | 8           | 9       | D3               | I/O                | Input/output 7. Referenced to $V_{CCA}$ .                                                       |
| A8          | 9           | 10      | E3               | I/O                | Input/output 8. Referenced to $V_{CCA}$ .                                                       |
| OE          | 10          | 6       | D4               | I                  | Output enable. Pull OE low to place all outputs in 3-state mode. Referenced to $V_{CCA}$ .      |
| GND         | 11          | 15      | D1               | S                  | Ground                                                                                          |
| B8          | 12          | 11      | E2               | I/O                | Input/output 8. Referenced to $V_{CCB}$ .                                                       |
| B7          | 13          | 12      | D2               | I/O                | Input/output 7. Referenced to $V_{CCB}$ .                                                       |
| B6          | 14          | 13      | E1               | I/O                | Input/output 6. Referenced to $V_{CCB}$ .                                                       |
| B5          | 15          | 14      | C2               | I/O                | Input/output 5. Referenced to $V_{CCB}$ .                                                       |
| B4          | 16          | 17      | B1               | I/O                | Input/output 4. Referenced to $V_{CCB}$ .                                                       |
| B3          | 17          | 18      | B2               | I/O                | Input/output 3. Referenced to $V_{CCB}$ .                                                       |
| B2          | 18          | 19      | A1               | I/O                | Input/output 2. Referenced to $V_{CCB}$ .                                                       |
| $V_{CCB}$   | 19          | 16      | C1               | S                  | B-port supply voltage. $1.65\text{ V} \leq V_{CCB} \leq 5.5\text{ V}$ .                         |
| B1          | 20          | 20      | A2               | I/O                | Input/output 1. Referenced to $V_{CCB}$ .                                                       |
| Thermal Pad | —           |         |                  | —                  | For the RGY/RUK package, the exposed center thermal pad must be connected to ground.            |

(1) I = input, O = output, I/O = input and output, S = power supply

**Table 4-2. Pin Assignments (20-Ball NME/GXY/ZXY Package)**

|          | 1         | 2  | 3  | 4  | 5   |
|----------|-----------|----|----|----|-----|
| <b>D</b> | $V_{CCB}$ | B2 | B4 | B6 | B8  |
| <b>C</b> | B1        | B3 | B5 | B7 | GND |
| <b>B</b> | A1        | A3 | A5 | A7 | OE  |
| <b>A</b> | $V_{CCA}$ | A2 | A4 | A6 | A8  |

## 5 Specifications

### 5.1 Absolute Maximum

over operating free-air temperature range (unless otherwise noted)

| (1)              |                                                                                             |                    | MIN  | MAX                    | UNIT |
|------------------|---------------------------------------------------------------------------------------------|--------------------|------|------------------------|------|
| V <sub>CCA</sub> | Supply voltage range                                                                        |                    | −0.5 | 4.6                    | V    |
| V <sub>CCB</sub> | Supply voltage range                                                                        |                    | −0.5 | 6.5                    | V    |
| V <sub>I</sub>   | Input voltage range <sup>(2)</sup>                                                          |                    | −0.5 | 6.5                    | V    |
| V <sub>O</sub>   | Voltage range applied to any output in the high-impedance or power-off state <sup>(2)</sup> |                    | −0.5 | 6.5                    | V    |
| V <sub>O</sub>   | Voltage range applied to any output in the high or low state <sup>(2) (3)</sup>             | A inputs           | −0.5 | V <sub>CCA</sub> + 0.5 | V    |
|                  |                                                                                             | B inputs           | −0.5 | V <sub>CCB</sub> + 0.5 |      |
| I <sub>IK</sub>  | Input clamp current                                                                         | V <sub>I</sub> < 0 | −50  |                        | mA   |
| I <sub>OK</sub>  | Output clamp current                                                                        | V <sub>O</sub> < 0 | −50  |                        | mA   |
| I <sub>O</sub>   | Continuous output current                                                                   |                    | ±50  |                        | mA   |
|                  | Continuous current through V <sub>CCA</sub> , V <sub>CCB</sub> , or GND                     |                    | ±100 |                        | mA   |
| T <sub>stg</sub> | Storage temperature range                                                                   |                    | −65  | 150                    | °C   |
| T <sub>J</sub>   | Junction temperature                                                                        |                    |      | 150                    | °C   |

- (1) Stresses beyond those listed under [Section 5.1](#) may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under [Section 5.3](#) is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The value of  $V_{CCA}$  and  $V_{CCB}$  are provided in the recommended operating conditions table.

### 5.2 Handling Ratings

|             |                         |                                                                                                                      | MIN | MAX | UNIT |
|-------------|-------------------------|----------------------------------------------------------------------------------------------------------------------|-----|-----|------|
| $V_{(ESD)}$ | Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup> , A Port                                 |     | 2   | kV   |
|             |                         | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup> , B Port                                 | −15 | 15  |      |
|             |                         | Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup> , A Port                    |     | 1   |      |
|             |                         | Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup> , A Port (YZP Package only) | −8  | 8   |      |
|             |                         | Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup> , B Port                    |     | 1   |      |

- (1) JEDEC document JEP155 states that 500V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250V CDM allows safe manufacturing with a standard ESD control process.

### 5.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted) <sup>(1) (2)</sup>

|                     |                                    |               | $V_{CCA}$    | $V_{CCB}$     | MIN                         | MAX                         | UNIT |
|---------------------|------------------------------------|---------------|--------------|---------------|-----------------------------|-----------------------------|------|
| $V_{CCA}$           | Supply voltage                     |               |              |               | 1.2                         | 3.6                         | V    |
| $V_{CCB}$           |                                    |               |              |               | 1.65                        | 5.5                         |      |
| $V_{IH}$            | High-level input voltage           | Data inputs   | 1.2V to 3.6V | 1.65V to 5.5V | $V_{CCI} \times 0.65^{(3)}$ | $V_{CCI}$                   | V    |
|                     |                                    | OE            |              |               | $V_{CCA} \times 0.65$       | 5.5                         |      |
| $V_{IL}$            | Low-level input voltage            | Data inputs   | 1.2V to 5.5V | 1.65V to 5.5V | 0                           | $V_{CCI} \times 0.35^{(3)}$ | V    |
|                     |                                    | OE            | 1.2V to 3.6V |               | 0                           | $V_{CCA} \times 0.35$       |      |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | A-port inputs | 1.2V to 3.6V | 1.65V to 5.5V |                             | 40                          | ns/V |
|                     |                                    | B-port inputs | 1.2V to 3.6V | 1.65V to 3.6V |                             | 40                          |      |
|                     |                                    |               |              | 4.5V to 5.5V  |                             | 30                          |      |

over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup> <sup>(2)</sup>

|                                      | $V_{CCA}$ | $V_{CCB}$ | MIN | MAX | UNIT |
|--------------------------------------|-----------|-----------|-----|-----|------|
| $T_A$ Operating free-air temperature |           |           | –40 | 85  | °C   |

- (1) The A and B sides of an unused data I/O pair must be held in the same state, i.e., both at  $V_{CCI}$  or both at GND.  
(2)  $V_{CCA}$  must be less than or equal to  $V_{CCB}$  and must not exceed 3.6V.  
(3)  $V_{CCI}$  is the supply voltage associated with the input port.

## 5.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | TXB0108 |      |       |      |       |       |       |      |       |      |      | UNIT |
|-------------------------------|----------------------------------------------|---------|------|-------|------|-------|-------|-------|------|-------|------|------|------|
|                               |                                              | PW      | RGY  | DQS   | YZP  | GXY   | ZXY   | NME   | RUK  | DGS   | RKS  |      |      |
|                               |                                              | 20 PINS |      |       |      |       |       |       |      |       |      |      |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 101.8   | 35.3 | 108.5 | 66.2 | 156.7 | 156.7 | 131.4 | 56.4 | 111.9 | 58.8 | °C/W |      |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 35.5    | 42.1 | 32.3  | 0.4  | 39.9  | 39.9  | 56.5  | 59.1 | 51.5  | 63.9 | °C/W |      |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 52.8    | 11.1 | 42.4  | 52.0 | 85.9  | 85.9  | 83.2  | 30.5 | 67    | 31.6 | °C/W |      |
| Ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 2.2     | 0.7  | 0.7   | 1.5  | 1.1   | 1.1   | 1.5   | 2.7  | 3.7   | 5.9  | °C/W |      |
| Ψ <sub>JB</sub>               | Junction-to-board characterization parameter | 52.2    | 11.2 | 42    | 51.9 | 85.4  | 85.4  | 82.6  | 30.5 | 66.2  | 31.6 | °C/W |      |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance | —       | 3.8  | —     | —    | —     | —     | —     | 15.1 | -     | 15.3 | °C/W |      |

- (1) For more information about traditional and new thermal metrics, see the [IC Package Thermal Metrics](#) application report.

## 5.5 Electrical Characteristics (DGS/RUK/RKS)

over recommended operating free-air temperature range (unless otherwise noted) <sup>(1)</sup> <sup>(2)</sup>

| PARAMETER                           |             | TEST CONDITIONS                                              | V <sub>CCA</sub> | V <sub>CCB</sub> | T <sub>A</sub> = 25°C |     |     | −40°C to 85°C          |     | UNIT |
|-------------------------------------|-------------|--------------------------------------------------------------|------------------|------------------|-----------------------|-----|-----|------------------------|-----|------|
|                                     |             |                                                              |                  |                  | MIN                   | TYP | MAX | MIN                    | MAX |      |
| V <sub>OHA</sub>                    |             | I <sub>OH</sub> = −20μA                                      | 1.2V             |                  | 1.1                   |     |     | V <sub>CCA</sub> − 0.4 |     | V    |
|                                     |             |                                                              | 1.4V to 3.6V     |                  |                       |     |     |                        |     |      |
| V <sub>OLA</sub>                    |             | I <sub>OL</sub> = 20μA                                       | 1.2V             |                  | 0.3                   |     |     | 0.4                    |     | V    |
|                                     |             |                                                              | 1.4V to 3.6V     |                  |                       |     |     |                        |     |      |
| V <sub>OHB</sub>                    |             | I <sub>OH</sub> = −20 μA                                     |                  | 1.65V to 5.5V    |                       |     |     | V <sub>CCB</sub> − 0.4 |     | V    |
| V <sub>OLB</sub>                    |             | I <sub>OL</sub> = 20μA                                       |                  | 1.65V to 5.5V    |                       |     |     | 0.4                    |     | V    |
| I <sub>I</sub>                      | OE          |                                                              | 1.2V to 3.6V     | 1.65V to 5.5V    | ±1                    |     |     | ±2                     |     | μA   |
| I <sub>off</sub>                    | A port      |                                                              | 0V               | 0V to 5.5V       | ±1                    |     |     | ±2                     |     | μA   |
|                                     | B port      |                                                              | 0V to 3.6V       | 0V               | ±1                    |     |     | ±2                     |     |      |
| I <sub>OZ</sub>                     | A or B port | OE = GND                                                     | 1.2V to 3.6V     | 1.65V to 5.5V    | ±1                    |     |     | ±2                     |     | μA   |
| I <sub>CCA</sub>                    |             | V <sub>I</sub> = V <sub>CCI</sub> or GND, I <sub>O</sub> = 0 | 1.2V             | 1.65V to 5.5V    | 0.45                  |     |     |                        |     | μA   |
|                                     |             |                                                              | 1.4V to 3.6V     |                  |                       |     |     | 5                      |     |      |
|                                     |             |                                                              | 3.6V             | 0V               |                       |     |     | 2                      |     |      |
|                                     |             |                                                              | 0V               | 5.5V             |                       |     |     | −2                     |     |      |
| I <sub>CCB</sub>                    |             | V <sub>I</sub> = V <sub>CCI</sub> or GND, I <sub>O</sub> = 0 | 1.2V             | 1.65V to 5.5V    | 3.4                   |     |     |                        |     | μA   |
|                                     |             |                                                              | 1.4V to 3.6V     |                  |                       |     |     | 5                      |     |      |
|                                     |             |                                                              | 3.6V             | 0V               |                       |     |     | −2                     |     |      |
|                                     |             |                                                              | 0V               | 5.5V             |                       |     |     | 2                      |     |      |
| I <sub>CCA</sub> + I <sub>CCB</sub> |             | V <sub>I</sub> = V <sub>CCI</sub> or GND, I <sub>O</sub> = 0 | 1.2V             | 1.65V to 5.5V    | 3.5                   |     |     |                        |     | μA   |
|                                     |             |                                                              | 1.4V to 3.6V     |                  |                       |     |     | 10                     |     |      |

over recommended operating free-air temperature range (unless otherwise noted)<sup>(1) (2)</sup>

| PARAMETER         |        | TEST<br>CONDITIONS                                                           | V <sub>CCA</sub> | V <sub>CCB</sub> | T <sub>A</sub> = 25°C |     |     | –40°C to 85°C |     | UNIT |
|-------------------|--------|------------------------------------------------------------------------------|------------------|------------------|-----------------------|-----|-----|---------------|-----|------|
|                   |        |                                                                              |                  |                  | MIN                   | TYP | MAX | MIN           | MAX |      |
| I <sub>CCZA</sub> |        | V <sub>I</sub> = V <sub>CCI</sub> or GND,<br>I <sub>O</sub> = 0,<br>OE = GND | 1.2V             | 1.65V to 5.5V    | 0.05                  |     |     |               |     | μA   |
|                   |        |                                                                              | 1.4V to 3.6V     |                  |                       |     |     | 5             |     |      |
| I <sub>CCZB</sub> |        | V <sub>I</sub> = V <sub>CCI</sub> or GND,<br>I <sub>O</sub> = 0,<br>OE = GND | 1.2V             | 1.65V to 5.5V    | 3.3                   |     |     |               |     | μA   |
|                   |        |                                                                              | 1.4V to 3.6V     |                  |                       |     |     | 5             |     |      |
| C <sub>I</sub>    | OE     |                                                                              | 1.2V to 3.6V     | 1.65V to 5.5V    | 5                     |     |     | 6.5           |     | pF   |
| C <sub>io</sub>   | A port |                                                                              | 1.2V to 3.6V     | 1.65V to 5.5V    | 5                     |     |     | 6.5           |     | pF   |
|                   | B port |                                                                              |                  |                  | 8                     |     |     | 13.3          |     |      |

(1) V<sub>CCi</sub> is the supply voltage associated with the input port.

(2) V<sub>CCO</sub> is the supply voltage associated with the output port.

## 5.6 Electrical Characteristics (Other Packages)

over recommended operating free-air temperature range (unless otherwise noted)<sup>(1) (2)</sup>

| PARAMETER                           |             | TEST<br>CONDITIONS                                                           | V <sub>CCA</sub> | V <sub>CCB</sub> | T <sub>A</sub> = 25°C |     |     | –40°C to 85°C          |     | UNIT |
|-------------------------------------|-------------|------------------------------------------------------------------------------|------------------|------------------|-----------------------|-----|-----|------------------------|-----|------|
|                                     |             |                                                                              |                  |                  | MIN                   | TYP | MAX | MIN                    | MAX |      |
| V <sub>OHA</sub>                    |             | I <sub>OH</sub> = –20μA                                                      | 1.2V             |                  | 1.1                   |     |     | V <sub>CCA</sub> – 0.4 |     | V    |
|                                     |             |                                                                              | 1.4V to 3.6V     |                  |                       |     |     |                        |     |      |
| V <sub>OLA</sub>                    |             | I <sub>OL</sub> = 20μA                                                       | 1.2V             |                  | 0.3                   |     |     | 0.4                    |     | V    |
|                                     |             |                                                                              | 1.4V to 3.6V     |                  |                       |     |     |                        |     |      |
| V <sub>OHB</sub>                    |             | I <sub>OH</sub> = –20μA                                                      |                  | 1.65V to 5.5V    |                       |     |     | V <sub>CCB</sub> – 0.4 |     | V    |
| V <sub>OLB</sub>                    |             | I <sub>OL</sub> = 20μA                                                       |                  | 1.65 V to 5.5 V  |                       |     |     | 0.4                    |     | V    |
| I <sub>I</sub>                      | OE          |                                                                              | 1.2V to 3.6V     | 1.65V to 5.5V    | ±1                    |     |     | ±2                     |     | μA   |
| I <sub>off</sub>                    | A port      |                                                                              | 0V               | 0V to 5.5V       | ±1                    |     |     | ±2                     |     | μA   |
|                                     | B port      |                                                                              | 0V to 3.6V       | 0V               | ±1                    |     |     | ±2                     |     |      |
| I <sub>OZ</sub>                     | A or B port | OE = GND                                                                     | 1.2V to 3.6V     | 1.65V to 5.5V    | ±1                    |     |     | ±2                     |     | μA   |
| I <sub>CCA</sub>                    |             | V <sub>I</sub> = V <sub>CCI</sub> or GND,<br>I <sub>O</sub> = 0              | 1.2V             | 1.65V to 5.5V    | 0.06                  |     |     |                        |     | μA   |
|                                     |             |                                                                              | 1.4V to 3.6V     |                  |                       |     |     |                        |     |      |
|                                     |             |                                                                              | 3.6V             | 0V               |                       |     |     | 2                      |     |      |
|                                     |             |                                                                              | 0V               | 5.5V             |                       |     |     | –2                     |     |      |
| I <sub>CCB</sub>                    |             | V <sub>I</sub> = V <sub>CCI</sub> or GND,<br>I <sub>O</sub> = 0              | 1.2V             | 1.65V to 5.5V    | 3.4                   |     |     |                        |     | μA   |
|                                     |             |                                                                              | 1.4V to 3.6V     |                  |                       |     |     |                        |     |      |
|                                     |             |                                                                              | 3.6V             | 0V               |                       |     |     | –2                     |     |      |
|                                     |             |                                                                              | 0V               | 5.5V             |                       |     |     | 2                      |     |      |
| I <sub>CCA</sub> + I <sub>CCB</sub> |             | V <sub>I</sub> = V <sub>CCI</sub> or GND,<br>I <sub>O</sub> = 0              | 1.2V             | 1.65V to 5.5V    | 3.5                   |     |     |                        |     | μA   |
|                                     |             |                                                                              | 1.4V to 3.6V     |                  |                       |     |     |                        |     |      |
| I <sub>CCZA</sub>                   |             | V <sub>I</sub> = V <sub>CCI</sub> or GND,<br>I <sub>O</sub> = 0,<br>OE = GND | 1.2V             | 1.65V to 5.5V    | 0.05                  |     |     |                        |     | μA   |
|                                     |             |                                                                              | 1.4V to 3.6V     |                  |                       |     |     |                        |     |      |
| I <sub>CCZB</sub>                   |             | V <sub>I</sub> = V <sub>CCI</sub> or GND,<br>I <sub>O</sub> = 0,<br>OE = GND | 1.2V             | 1.65V to 5.5V    | 3.3                   |     |     |                        |     | μA   |
|                                     |             |                                                                              | 1.4V to 3.6V     |                  |                       |     |     |                        |     |      |
| C <sub>I</sub>                      | OE          |                                                                              | 1.2V to 3.6V     | 1.65V to 5.5V    | 5                     |     |     | 5.5                    |     | pF   |
| C <sub>io</sub>                     | A port      |                                                                              | 1.2V to 3.6V     | 1.65V to 5.5V    | 5                     |     |     | 6.5                    |     | pF   |
|                                     | B port      |                                                                              |                  |                  | 8                     |     |     | 10                     |     |      |

(1) V<sub>CCi</sub> is the supply voltage associated with the input port.



(2)  $V_{CCO}$  is the supply voltage associated with the output port.

### 5.7 Timing Requirements: $V_{CCA} = 1.2V$

$T_A = 25^\circ C$ ,  $V_{CCA} = 1.2V$

|           |                |             | $V_{CCB} = 1.8V$ | $V_{CCB} = 2.5V$ | $V_{CCB} = 3.3V$ | $V_{CCB} = 5V$ | UNIT |
|-----------|----------------|-------------|------------------|------------------|------------------|----------------|------|
|           |                |             | TYP              | TYP              | TYP              | TYP            |      |
| Data rate |                |             | 20               | 20               | 20               | 20             | Mbps |
| $t_w$     | Pulse duration | Data inputs | 50               | 50               | 50               | 50             | ns   |

### 5.8 Timing Requirements: $V_{CCA} = 1.5V \pm 0.1V$

over recommended operating free-air temperature range,  $V_{CCA} = 1.5V \pm 0.1V$  (unless otherwise noted)

|           |                |             | $V_{CCB} = 1.8V \pm 0.15V$ |     | $V_{CCB} = 2.5V \pm 0.2V$ |     | $V_{CCB} = 3.3V \pm 0.3V$ |     | $V_{CCB} = 5V \pm 0.5V$ |     | UNIT |
|-----------|----------------|-------------|----------------------------|-----|---------------------------|-----|---------------------------|-----|-------------------------|-----|------|
|           |                |             | MIN                        | MAX | MIN                       | MAX | MIN                       | MAX | MIN                     | MAX |      |
| Data rate |                |             | 50                         |     | 50                        |     | 50                        |     | 50                      |     | Mbps |
| $t_w$     | Pulse duration | Data inputs | 20                         |     | 20                        |     | 20                        |     | 20                      |     | ns   |

### 5.9 Timing Requirements: $V_{CCA} = 1.8V \pm 0.15V$

over recommended operating free-air temperature range,  $V_{CCA} = 1.8V \pm 0.15V$  (unless otherwise noted)

|           |                |             | $V_{CCB} = 1.8V \pm 0.15V$ |     | $V_{CCB} = 2.5V \pm 0.2V$ |     | $V_{CCB} = 3.3V \pm 0.3V$ |     | $V_{CCB} = 5V \pm 0.5V$ |     | UNIT |
|-----------|----------------|-------------|----------------------------|-----|---------------------------|-----|---------------------------|-----|-------------------------|-----|------|
|           |                |             | MIN                        | MAX | MIN                       | MAX | MIN                       | MAX | MIN                     | MAX |      |
| Data rate |                |             | 52                         |     | 60                        |     | 60                        |     | 60                      |     | Mbps |
| $t_w$     | Pulse duration | Data inputs | 19                         |     | 17                        |     | 17                        |     | 17                      |     | ns   |

### 5.10 Timing Requirements: $V_{CCA} = 2.5V \pm 0.2V$

over recommended operating free-air temperature range,  $V_{CCA} = 2.5V \pm 0.2V$  (unless otherwise noted)

|           |                |             | $V_{CCB} = 2.5V \pm 0.2V$ |     | $V_{CCB} = 3.3V \pm 0.3V$ |     | $V_{CCB} = 5V \pm 0.5V$ |     | UNIT |
|-----------|----------------|-------------|---------------------------|-----|---------------------------|-----|-------------------------|-----|------|
|           |                |             | MIN                       | MAX | MIN                       | MAX | MIN                     | MAX |      |
| Data rate |                |             | 70                        |     | 100                       |     | 100                     |     | Mbps |
| $t_w$     | Pulse duration | Data inputs | 14                        |     | 10                        |     | 10                      |     | ns   |

### 5.11 Timing Requirements: $V_{CCA} = 3.3V \pm 0.3V$

over recommended operating free-air temperature range,  $V_{CCA} = 3.3V \pm 0.3V$  (unless otherwise noted)

|           |                |             | $V_{CCB} = 3.3V \pm 0.3V$ |     | $V_{CCB} = 5V \pm 0.5V$ |     | UNIT |
|-----------|----------------|-------------|---------------------------|-----|-------------------------|-----|------|
|           |                |             | MIN                       | MAX | MIN                     | MAX |      |
| Data rate |                |             | 100                       |     | 100                     |     | Mbps |
| $t_w$     | Pulse duration | Data inputs | 10                        |     | 10                      |     | ns   |

### 5.12 Switching Characteristics: $V_{CCA} = 1.2V$ (DGS/RUK/RKS)

$T_A = 25^\circ C$ ,  $V_{CCA} = 1.2V$

| PARAMETER | FROM<br>(INPUT) | TO<br>(OUTPUT) | $V_{CCB} = 1.8V$ | $V_{CCB} = 2.5V$ | $V_{CCB} = 3.3V$ | $V_{CCB} = 5V$ | UNIT |
|-----------|-----------------|----------------|------------------|------------------|------------------|----------------|------|
|           |                 |                | TYP              | TYP              | TYP              | TYP            |      |
| $t_{pd}$  | A               | B              | 9.5              | 7.9              | 7.6              | 8.5            | ns   |
|           | B               | A              | 9.2              | 8.8              | 8.4              | 8              |      |

$T_A = 25^\circ\text{C}$ ,  $V_{CCA} = 1.2\text{V}$ 

| PARAMETER           | FROM<br>(INPUT)            | TO<br>(OUTPUT) | $V_{CCB} = 1.8\text{V}$ | $V_{CCB} = 2.5\text{V}$ | $V_{CCB} = 3.3\text{V}$ | $V_{CCB} = 5\text{V}$ | UNIT          |
|---------------------|----------------------------|----------------|-------------------------|-------------------------|-------------------------|-----------------------|---------------|
|                     |                            |                | TYP                     | TYP                     | TYP                     | TYP                   |               |
| $t_{\text{en}}$     | OE                         | A              | 1                       | 1                       | 1                       | 1                     | $\mu\text{s}$ |
|                     |                            | B              | 1                       | 1                       | 1                       | 1                     |               |
| $t_{\text{dis}}$    | OE                         | A              | 392                     | 392                     | 392                     | 392                   | ns            |
|                     |                            | B              | 392                     | 392                     | 392                     | 392                   |               |
| $t_{rA}$ , $t_{fA}$ | A-port rise and fall times |                | 4.1                     | 4.4                     | 4.1                     | 3.9                   | ns            |
| $t_{rB}$ , $t_{fB}$ | B-port rise and fall times |                | 5                       | 5                       | 5.1                     | 5.1                   | ns            |
| $t_{\text{SK(O)}}$  | Channel-to-channel skew    |                | 2.4                     | 1.7                     | 1.9                     | 7                     | ns            |
| Max data rate       |                            |                | 20                      | 20                      | 20                      | 20                    | Mbps          |

### 5.13 Switching Characteristics: $V_{CCA} = 1.2\text{V}$ (Other Packages)

 $T_A = 25^\circ\text{C}$ ,  $V_{CCA} = 1.2\text{V}$ 

| PARAMETER           | FROM<br>(INPUT)            | TO<br>(OUTPUT) | $V_{CCB} = 1.8\text{V}$ | $V_{CCB} = 2.5\text{V}$ | $V_{CCB} = 3.3\text{V}$ | $V_{CCB} = 5\text{V}$ | UNIT          |
|---------------------|----------------------------|----------------|-------------------------|-------------------------|-------------------------|-----------------------|---------------|
|                     |                            |                | TYP                     | TYP                     | TYP                     | TYP                   |               |
| $t_{\text{pd}}$     | A                          | B              | 9.5                     | 7.9                     | 7.6                     | 8.5                   | ns            |
|                     | B                          | A              | 9.2                     | 8.8                     | 8.4                     | 8                     |               |
| $t_{\text{en}}$     | OE                         | A              | 1                       | 1                       | 1                       | 1                     | $\mu\text{s}$ |
|                     |                            | B              | 1                       | 1                       | 1                       | 1                     |               |
| $t_{\text{dis}}$    | OE                         | A              | 20                      | 17                      | 17                      | 18                    | ns            |
|                     |                            | B              | 20                      | 16                      | 15                      | 15                    |               |
| $t_{rA}$ , $t_{fA}$ | A-port rise and fall times |                | 4.1                     | 4.4                     | 4.1                     | 3.9                   | ns            |
| $t_{rB}$ , $t_{fB}$ | B-port rise and fall times |                | 5                       | 5                       | 5.1                     | 5.1                   | ns            |
| $t_{\text{SK(O)}}$  | Channel-to-channel skew    |                | 2.4                     | 1.7                     | 1.9                     | 7                     | ns            |
| Max data rate       |                            |                | 20                      | 20                      | 20                      | 20                    | Mbps          |

### 5.14 Switching Characteristics: $V_{CCA} = 1.5\text{V} \pm 0.1\text{V}$ (DGS/RUK/RKS)

 over recommended operating free-air temperature range,  $V_{CCA} = 1.5\text{V} \pm 0.1\text{V}$  (unless otherwise noted)

| PARAMETER           | FROM<br>(INPUT)            | TO<br>(OUTPUT) | $V_{CCB} = 1.8\text{V} \pm 0.15\text{V}$ |      | $V_{CCB} = 2.5\text{V} \pm 0.2\text{V}$ |      | $V_{CCB} = 3.3\text{V} \pm 0.3\text{V}$ |      | $V_{CCB} = 5\text{V} \pm 0.5\text{V}$ |      | UNIT          |
|---------------------|----------------------------|----------------|------------------------------------------|------|-----------------------------------------|------|-----------------------------------------|------|---------------------------------------|------|---------------|
|                     |                            |                | MIN                                      | MAX  | MIN                                     | MAX  | MIN                                     | MAX  | MIN                                   | MAX  |               |
| $t_{\text{pd}}$     | A                          | B              | 1.4                                      | 12.9 | 1.2                                     | 10.1 | 1.1                                     | 10   | 0.8                                   | 9.9  | ns            |
|                     | B                          | A              | 0.9                                      | 14.2 | 0.7                                     | 12   | 0.4                                     | 11.7 | 0.3                                   | 13.7 |               |
| $t_{\text{en}}$     | OE                         | A              |                                          | 1    |                                         | 1    |                                         | 1    |                                       | 1    | $\mu\text{s}$ |
|                     |                            | B              |                                          | 1    |                                         | 1    |                                         | 1    |                                       | 1    |               |
| $t_{\text{dis}}$    | OE                         | A              | 278                                      | 390  | 236                                     | 305  | 236                                     | 305  | 236                                   | 305  | ns            |
|                     |                            | B              | 278                                      | 390  | 236                                     | 305  | 236                                     | 305  | 236                                   | 305  |               |
| $t_{rA}$ , $t_{fA}$ | A-port rise and fall times |                | 0.8                                      | 6.5  | 0.8                                     | 6.3  | 0.8                                     | 6.3  | 0.8                                   | 6.3  | ns            |
| $t_{rB}$ , $t_{fB}$ | B-port rise and fall times |                | 1                                        | 7.3  | 0.7                                     | 4.9  | 0.7                                     | 4.6  | 0.6                                   | 4.6  | ns            |
| $t_{\text{SK(O)}}$  | Channel-to-channel skew    |                |                                          | 2.6  |                                         | 1.9  |                                         | 1.6  |                                       | 1.3  | ns            |
| Max data rate       |                            |                | 50                                       |      | 50                                      |      | 50                                      |      | 50                                    |      | Mbps          |

### 5.15 Switching Characteristics: $V_{CCA} = 1.5V \pm 0.1V$ (Other Packages)

over recommended operating free-air temperature range,  $V_{CCA} = 1.5V \pm 0.1V$  (unless otherwise noted)

| PARAMETER        | FROM<br>(INPUT)            | TO<br>(OUTPUT) | $V_{CCB} = 1.8V \pm 0.15V$ |      | $V_{CCB} = 2.5V \pm 0.2V$ |      | $V_{CCB} = 3.3V \pm 0.3V$ |      | $V_{CCB} = 5V \pm 0.5V$ |      | UNIT    |
|------------------|----------------------------|----------------|----------------------------|------|---------------------------|------|---------------------------|------|-------------------------|------|---------|
|                  |                            |                | MIN                        | MAX  | MIN                       | MAX  | MIN                       | MAX  | MIN                     | MAX  |         |
| $t_{pd}$         | A                          | B              | 1.4                        | 12.9 | 1.2                       | 10.1 | 1.1                       | 10   | 0.8                     | 9.9  | ns      |
|                  | B                          | A              | 0.9                        | 14.2 | 0.7                       | 12   | 0.4                       | 11.7 | 0.3                     | 13.7 |         |
| $t_{en}$         | OE                         | A              |                            | 1    |                           | 1    |                           | 1    |                         | 1    | $\mu s$ |
|                  |                            | B              |                            | 1    |                           | 1    |                           | 1    |                         | 1    |         |
| $t_{dis}$        | OE                         | A              | 6.6                        | 33   | 6.4                       | 25.3 | 6.1                       | 23.1 | 5.9                     | 24.6 | ns      |
|                  |                            | B              | 6.6                        | 35.6 | 5.8                       | 25.6 | 5.5                       | 22.1 | 5.6                     | 20.6 |         |
| $t_{rA}, t_{fA}$ | A-port rise and fall times |                | 0.8                        | 6.5  | 0.8                       | 6.3  | 0.8                       | 6.3  | 0.8                     | 6.3  | ns      |
| $t_{rB}, t_{fB}$ | B-port rise and fall times |                | 1                          | 7.3  | 0.7                       | 4.9  | 0.7                       | 4.6  | 0.6                     | 4.6  | ns      |
| $t_{SK(O)}$      | Channel-to-channel skew    |                |                            | 2.6  |                           | 1.9  |                           | 1.6  |                         | 1.3  | ns      |
| Max data rate    |                            |                | 50                         |      | 50                        |      | 50                        |      | 50                      |      | Mbps    |

### 5.16 Switching Characteristics: $V_{CCA} = 1.8V \pm 0.15V$ (DGS/RUK/RKS)

over recommended operating free-air temperature range,  $V_{CCA} = 1.8V \pm 0.15V$  (unless otherwise noted)

| PARAMETER        | FROM<br>(INPUT)            | TO<br>(OUTPUT) | $V_{CCB} = 1.8V \pm 0.15V$ |     | $V_{CCB} = 2.5V \pm 0.2V$ |     | $V_{CCB} = 3.3V \pm 0.3V$ |     | $V_{CCB} = 5V \pm 0.5V$ |     | UNIT    |
|------------------|----------------------------|----------------|----------------------------|-----|---------------------------|-----|---------------------------|-----|-------------------------|-----|---------|
|                  |                            |                | MIN                        | MAX | MIN                       | MAX | MIN                       | MAX | MIN                     | MAX |         |
| $t_{pd}$         | A                          | B              | 1.6                        | 11  | 1.4                       | 7.7 | 1.3                       | 6.8 | 1.2                     | 6.5 | ns      |
|                  | B                          | A              | 1.5                        | 12  | 1.2                       | 8.4 | 0.8                       | 7.6 | 0.5                     | 7.1 |         |
| $t_{en}$         | OE                         | A              |                            | 1   |                           | 1   |                           | 1   |                         | 1   | $\mu s$ |
|                  |                            | B              |                            | 1   |                           | 1   |                           | 1   |                         | 1   |         |
| $t_{dis}$        | OE                         | A              | 278                        | 389 | 191                       | 253 | 190                       | 248 | 189                     | 248 | ns      |
|                  |                            | B              | 278                        | 389 | 191                       | 253 | 190                       | 248 | 189                     | 248 |         |
| $t_{rA}, t_{fA}$ | A-port rise and fall times |                | 0.7                        | 5.1 | 0.7                       | 5   | 1                         | 5   | 0.7                     | 5   | ns      |
| $t_{rB}, t_{fB}$ | B-port rise and fall times |                | 1                          | 7.3 | 0.7                       | 5   | 0.7                       | 3.9 | 0.6                     | 3.8 | ns      |
| $t_{SK(O)}$      | Channel-to-channel skew    |                |                            | 0.8 |                           | 0.7 |                           | 0.6 |                         | 0.6 | ns      |
| Max data rate    |                            |                | 52                         |     | 60                        |     | 60                        |     | 60                      |     | Mbps    |

### 5.17 Switching Characteristics: $V_{CCA} = 1.8V \pm 0.15V$ (Other Packages)

over recommended operating free-air temperature range,  $V_{CCA} = 1.8V \pm 0.15V$  (unless otherwise noted)

| PARAMETER        | FROM<br>(INPUT)            | TO<br>(OUTPUT) | $V_{CCB} = 1.8V \pm 0.15V$ |      | $V_{CCB} = 2.5V \pm 0.2V$ |      | $V_{CCB} = 3.3V \pm 0.3V$ |      | $V_{CCB} = 5V \pm 0.5V$ |      | UNIT    |
|------------------|----------------------------|----------------|----------------------------|------|---------------------------|------|---------------------------|------|-------------------------|------|---------|
|                  |                            |                | MIN                        | MAX  | MIN                       | MAX  | MIN                       | MAX  | MIN                     | MAX  |         |
| $t_{pd}$         | A                          | B              | 1.6                        | 11   | 1.4                       | 7.7  | 1.3                       | 6.8  | 1.2                     | 6.5  | ns      |
|                  | B                          | A              | 1.5                        | 12   | 1.2                       | 8.4  | 0.8                       | 7.6  | 0.5                     | 7.1  |         |
| $t_{en}$         | OE                         | A              |                            | 1    |                           | 1    |                           | 1    |                         | 1    | $\mu s$ |
|                  |                            | B              |                            | 1    |                           | 1    |                           | 1    |                         | 1    |         |
| $t_{dis}$        | OE                         | A              | 5.9                        | 26.7 | 5.6                       | 21.6 | 5.4                       | 18.9 | 4.8                     | 18.7 | ns      |
|                  |                            | B              | 6.1                        | 33.9 | 5.2                       | 23.7 | 5                         | 19.9 | 5                       | 17.6 |         |
| $t_{rA}, t_{fA}$ | A-port rise and fall times |                | 0.7                        | 5.1  | 0.7                       | 5    | 1                         | 5    | 0.7                     | 5    | ns      |
| $t_{rB}, t_{fB}$ | B-port rise and fall times |                | 1                          | 7.3  | 0.7                       | 5    | 0.7                       | 3.9  | 0.6                     | 3.8  | ns      |
| $t_{SK(O)}$      | Channel-to-channel skew    |                |                            | 0.8  |                           | 0.7  |                           | 0.6  |                         | 0.6  | ns      |

over recommended operating free-air temperature range,  $V_{CCA} = 1.8V \pm 0.15V$  (unless otherwise noted)

| PARAMETER     | FROM<br>(INPUT) | TO<br>(OUTPUT) | $V_{CCB} = 1.8V \pm 0.15V$ |     | $V_{CCB} = 2.5V \pm 0.2V$ |     | $V_{CCB} = 3.3V \pm 0.3V$ |     | $V_{CCB} = 5V \pm 0.5V$ |     | UNIT |
|---------------|-----------------|----------------|----------------------------|-----|---------------------------|-----|---------------------------|-----|-------------------------|-----|------|
|               |                 |                | MIN                        | MAX | MIN                       | MAX | MIN                       | MAX | MIN                     | MAX |      |
| Max data rate |                 |                | 52                         |     | 60                        |     | 60                        |     | 60                      |     | Mbps |

### 5.18 Switching Characteristics: $V_{CCA} = 2.5V \pm 0.2V$ (DGS/RUK/RKS)

over recommended operating free-air temperature range,  $V_{CCA} = 2.5V \pm 0.2V$  (unless otherwise noted)

| PARAMETER        | FROM<br>(INPUT)            | TO<br>(OUTPUT) | $V_{CCB} = 2.5V \pm 0.2V$ |     | $V_{CCB} = 3.3V \pm 0.3V$ |     | $V_{CCB} = 5V \pm 0.5V$ |     | UNIT    |
|------------------|----------------------------|----------------|---------------------------|-----|---------------------------|-----|-------------------------|-----|---------|
|                  |                            |                | MIN                       | MAX | MIN                       | MAX | MIN                     | MAX |         |
| $t_{pd}$         | A                          | B              | 1.1                       | 6.4 | 1                         | 5.3 | 0.9                     | 4.7 | ns      |
|                  | B                          | A              | 1                         | 7   | 0.6                       | 5.6 | 0.3                     | 4.4 |         |
| $t_{en}$         | OE                         | A              |                           | 1   |                           | 1   |                         | 1   | $\mu s$ |
|                  |                            | B              |                           | 1   |                           | 1   |                         | 1   |         |
| $t_{dis}$        | OE                         | A              | 190                       | 252 | 137                       | 184 | 133                     | 169 | ns      |
|                  |                            | B              | 190                       | 252 | 137                       | 184 | 133                     | 169 |         |
| $t_{rA}, t_{fA}$ | A-port rise and fall times |                | 0.8                       | 3.6 | 0.6                       | 3.6 | 0.5                     | 3.5 | ns      |
| $t_{rB}, t_{fB}$ | B-port rise and fall times |                | 0.6                       | 4.9 | 0.7                       | 3.9 | 0.6                     | 3.2 | ns      |
| $t_{SK(O)}$      | Channel-to-channel skew    |                |                           | 0.4 |                           | 0.3 |                         | 0.3 | ns      |
| Max data rate    |                            |                | 70                        |     | 100                       |     | 100                     |     | Mbps    |

### 5.19 Switching Characteristics: $V_{CCA} = 2.5V \pm 0.2V$ (Other Packages)

over recommended operating free-air temperature range,  $V_{CCA} = 2.5V \pm 0.2V$  (unless otherwise noted)

| PARAMETER        | FROM<br>(INPUT)            | TO<br>(OUTPUT) | $V_{CCB} = 2.5V \pm 0.2V$ |      | $V_{CCB} = 3.3V \pm 0.3V$ |      | $V_{CCB} = 5V \pm 0.5V$ |      | UNIT    |
|------------------|----------------------------|----------------|---------------------------|------|---------------------------|------|-------------------------|------|---------|
|                  |                            |                | MIN                       | MAX  | MIN                       | MAX  | MIN                     | MAX  |         |
| $t_{pd}$         | A                          | B              | 1.1                       | 6.4  | 1                         | 5.3  | 0.9                     | 4.7  | ns      |
|                  | B                          | A              | 1                         | 7    | 0.6                       | 5.6  | 0.3                     | 4.4  |         |
| $t_{en}$         | OE                         | A              |                           | 1    |                           | 1    |                         | 1    | $\mu s$ |
|                  |                            | B              |                           | 1    |                           | 1    |                         | 1    |         |
| $t_{dis}$        | OE                         | A              | 5                         | 16.9 | 4.9                       | 15   | 4.5                     | 13.8 | ns      |
|                  |                            | B              | 4.8                       | 21.8 | 4.5                       | 17.9 | 4.4                     | 15.2 |         |
| $t_{rA}, t_{fA}$ | A-port rise and fall times |                | 0.8                       | 3.6  | 0.6                       | 3.6  | 0.5                     | 3.5  | ns      |
| $t_{rB}, t_{fB}$ | B-port rise and fall times |                | 0.6                       | 4.9  | 0.7                       | 3.9  | 0.6                     | 3.2  | ns      |
| $t_{SK(O)}$      | Channel-to-channel skew    |                |                           | 0.4  |                           | 0.3  |                         | 0.3  | ns      |
| Max data rate    |                            |                | 70                        |      | 100                       |      | 100                     |      | Mbps    |

### 5.20 Switching Characteristics: $V_{CCA} = 3.3V \pm 0.3V$ (DGS/RUK/RKS)

over recommended operating free-air temperature range,  $V_{CCA} = 3.3V \pm 0.3V$  (unless otherwise noted)

| PARAMETER | FROM<br>(INPUT) | TO<br>(OUTPUT) | $V_{CCB} = 3.3V \pm 0.3V$ |     | $V_{CCB} = 5V \pm 0.5V$ |     | UNIT    |
|-----------|-----------------|----------------|---------------------------|-----|-------------------------|-----|---------|
|           |                 |                | MIN                       | MAX | MIN                     | MAX |         |
| $t_{pd}$  | A               | B              | 0.9                       | 4.9 | 0.8                     | 4   | ns      |
|           | B               | A              | 0.5                       | 5.4 | 0.2                     | 4   |         |
| $t_{en}$  | OE              | A              |                           | 1   |                         | 1   | $\mu s$ |
|           |                 | B              |                           | 1   |                         | 1   |         |

over recommended operating free-air temperature range,  $V_{CCA} = 3.3V \pm 0.3V$  (unless otherwise noted)

| PARAMETER        | FROM<br>(INPUT)            | TO<br>(OUTPUT) | $V_{CCB} = 3.3V \pm 0.3V$ |     | $V_{CCB} = 5V \pm 0.5V$ |     | UNIT |
|------------------|----------------------------|----------------|---------------------------|-----|-------------------------|-----|------|
|                  |                            |                | MIN                       | MAX | MIN                     | MAX |      |
| $t_{dis}$        | OE                         | A              | 137                       | 183 | 97.6                    | 127 | ns   |
|                  |                            | B              | 137                       | 183 | 97.6                    | 127 |      |
| $t_{rA}, t_{fA}$ | A-port rise and fall times |                | 0.5                       | 3   | 0.5                     | 3   | ns   |
| $t_{rB}, t_{fB}$ | B-port rise and fall times |                | 0.7                       | 3.9 | 0.6                     | 3.2 | ns   |
| $t_{SK(O)}$      | Channel-to-channel skew    |                | 0.4                       |     | 0.3                     |     | ns   |
| Max data rate    |                            |                | 100                       |     | 100                     |     | Mbps |

## 5.21 Switching Characteristics: $V_{CCA} = 3.3V \pm 0.3V$ (Other Packages)

over recommended operating free-air temperature range,  $V_{CCA} = 3.3V \pm 0.3V$  (unless otherwise noted)

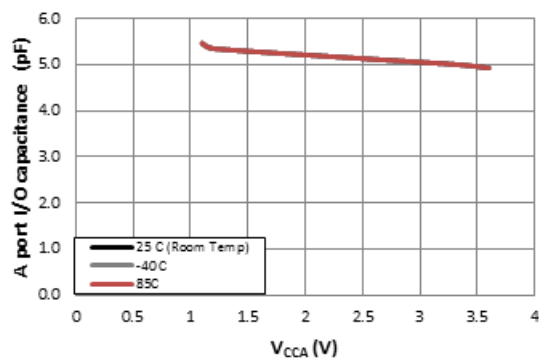
| PARAMETER                         | FROM<br>(INPUT)            | TO<br>(OUTPUT) | V <sub>CCB</sub> = 3.3V<br>± 0.3V |      | V <sub>CCB</sub> = 5V<br>± 0.5V |      | UNIT |
|-----------------------------------|----------------------------|----------------|-----------------------------------|------|---------------------------------|------|------|
|                                   |                            |                | MIN                               | MAX  | MIN                             | MAX  |      |
| t <sub>pd</sub>                   | A                          | B              | 0.9                               | 4.9  | 0.8                             | 4    | ns   |
|                                   | B                          | A              | 0.5                               | 5.4  | 0.2                             | 4    |      |
| t <sub>en</sub>                   | OE                         | A              | 1                                 |      | 1                               |      | μs   |
|                                   |                            | B              | 1                                 |      | 1                               |      |      |
| t <sub>dis</sub>                  | OE                         | A              | 4.5                               | 13.9 | 4.1                             | 12.4 | ns   |
|                                   |                            | B              | 4.1                               | 17.3 | 4                               | 14.4 |      |
| t <sub>rA</sub> , t <sub>fA</sub> | A-port rise and fall times |                | 0.5                               | 3    | 0.5                             | 3    | ns   |
| t <sub>rB</sub> , t <sub>fB</sub> | B-port rise and fall times |                | 0.7                               | 3.9  | 0.6                             | 3.2  | ns   |
| t <sub>SK(O)</sub>                | Channel-to-channel skew    |                | 0.4                               |      | 0.3                             |      | ns   |
| Max data rate                     |                            |                | 100                               |      | 100                             |      | Mbps |

## 5.22 Operating Characteristics

$T_A = 25^\circ C$

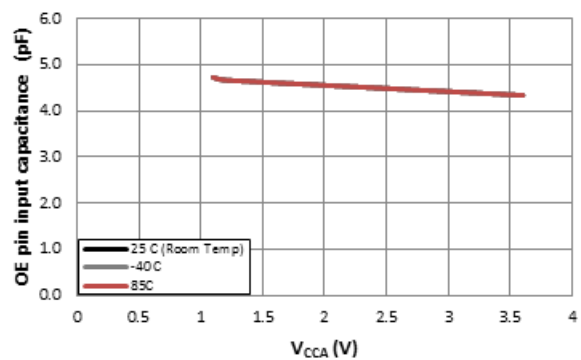
| PARAMETER        |                             | TEST CONDITIONS                                                                                                        | V <sub>CCA</sub> |      |      |      |      |      |            | UNIT |
|------------------|-----------------------------|------------------------------------------------------------------------------------------------------------------------|------------------|------|------|------|------|------|------------|------|
|                  |                             |                                                                                                                        | 1.2V             | 1.2V | 1.5V | 1.8V | 2.5V | 2.5V | 3.3V       |      |
|                  |                             |                                                                                                                        | V <sub>CCB</sub> |      |      |      |      |      |            |      |
|                  |                             |                                                                                                                        | 5V               | 1.8V | 1.8V | 1.8V | 2.5V | 5V   | 3.3V to 5V |      |
|                  |                             |                                                                                                                        | TYP              | TYP  | TYP  | TYP  | TYP  | TYP  | TYP        |      |
| C <sub>pdA</sub> | A-port input, B-port output | C <sub>L</sub> = 0, f = 10MHz,<br>t <sub>r</sub> = t <sub>f</sub> = 1ns,<br>OE = V <sub>CCA</sub><br>(outputs enabled) | 9                | 8    | 7    | 7    | 7    | 7    | 8          | pF   |
|                  | B-port input, A-port output |                                                                                                                        | 12               | 11   | 11   | 11   | 11   | 11   | 11         |      |
| C <sub>pdB</sub> | A-port input, B-port output |                                                                                                                        | 35               | 26   | 27   | 27   | 27   | 27   | 28         |      |
|                  | B-port input, A-port output |                                                                                                                        | 26               | 19   | 18   | 18   | 18   | 20   | 21         |      |
| C <sub>pdA</sub> | A-port input, B-port output | C <sub>L</sub> = 0, f = 10MHz,<br>t <sub>r</sub> = t <sub>f</sub> = 1ns,<br>OE = GND<br>(outputs disabled)             | 0.01             | 0.01 | 0.01 | 0.01 | 0.01 | 0.01 | 0.01       | pF   |
|                  | B-port input, A-port output |                                                                                                                        | 0.01             | 0.01 | 0.01 | 0.01 | 0.01 | 0.01 | 0.01       |      |
| C <sub>pdB</sub> | A-port input, B-port output |                                                                                                                        | 0.01             | 0.01 | 0.01 | 0.01 | 0.01 | 0.01 | 0.03       |      |
|                  | B-port input, A-port output |                                                                                                                        | 0.01             | 0.01 | 0.01 | 0.01 | 0.01 | 0.01 | 0.03       |      |

## 5.23 Typical Characteristics



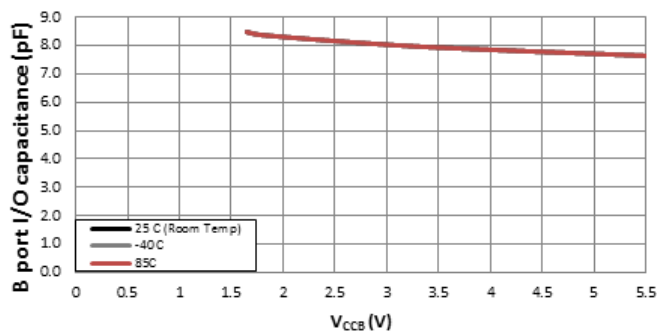
$V_{CCB} = 3.3V$

**Figure 5-1. Input Capacitance for OE Pin ( $C_I$ ) vs Power Supply ( $V_{CCA}$ )**



$V_{CCB} = 3.3V$

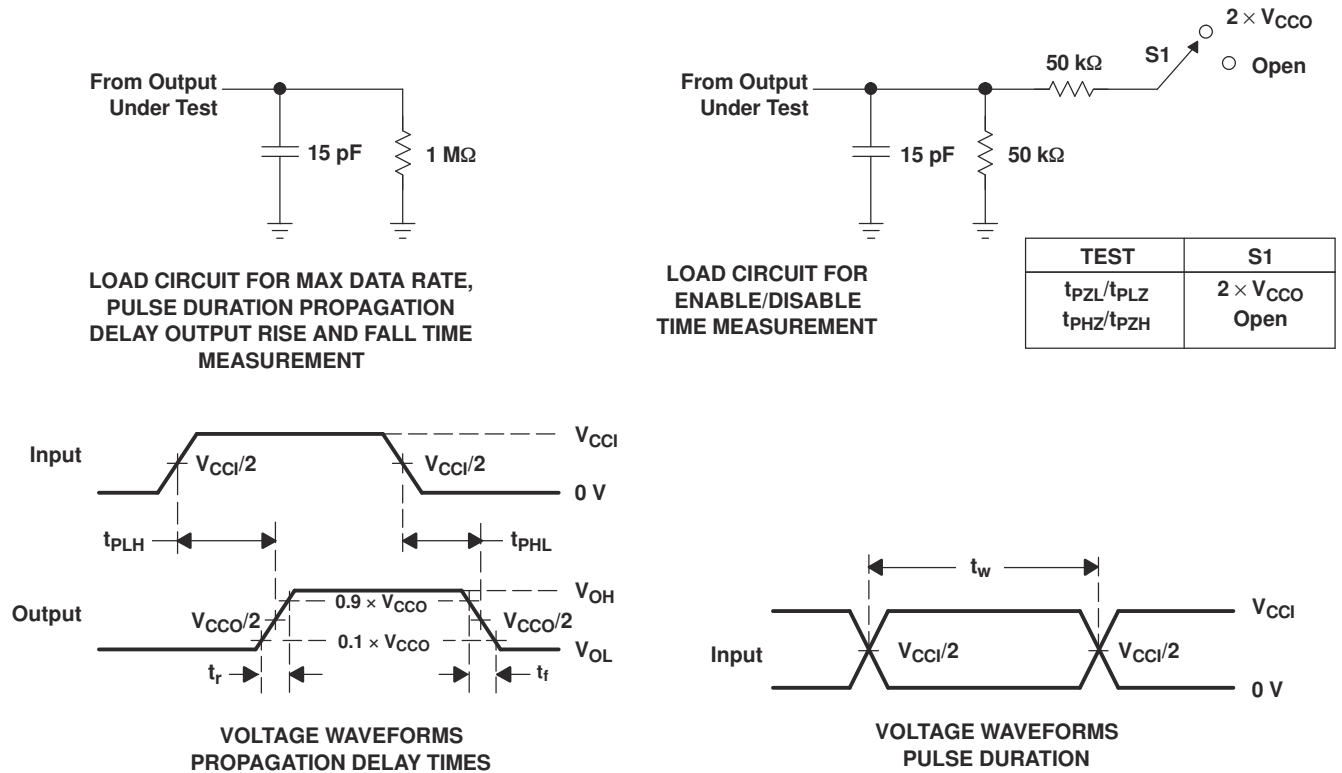
**Figure 5-2. Capacitance for A Port I/O Pins ( $C_{IO}$ ) vs Power Supply ( $V_{CCA}$ )**



$V_{CCA} = 1.8V$

**Figure 5-3. Capacitance for B Port I/O Pins ( $C_{IO}$ ) vs Power Supply ( $V_{CCB}$ )**

## 6 Parameter Measurement Information



- A.  $C_L$  includes probe and jig capacitance.
- B. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10$  MHz,  $Z_O = 50 \Omega$ ,  $dv/dt \geq 1$  V/ns.
- C. The outputs are measured one at a time, with one transition per measurement.
- D.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
- E.  $V_{CCI}$  is the  $V_{CC}$  associated with the input port.
- F.  $V_{CCO}$  is the  $V_{CC}$  associated with the output port.
- G. All parameters and waveforms are not applicable to all devices.

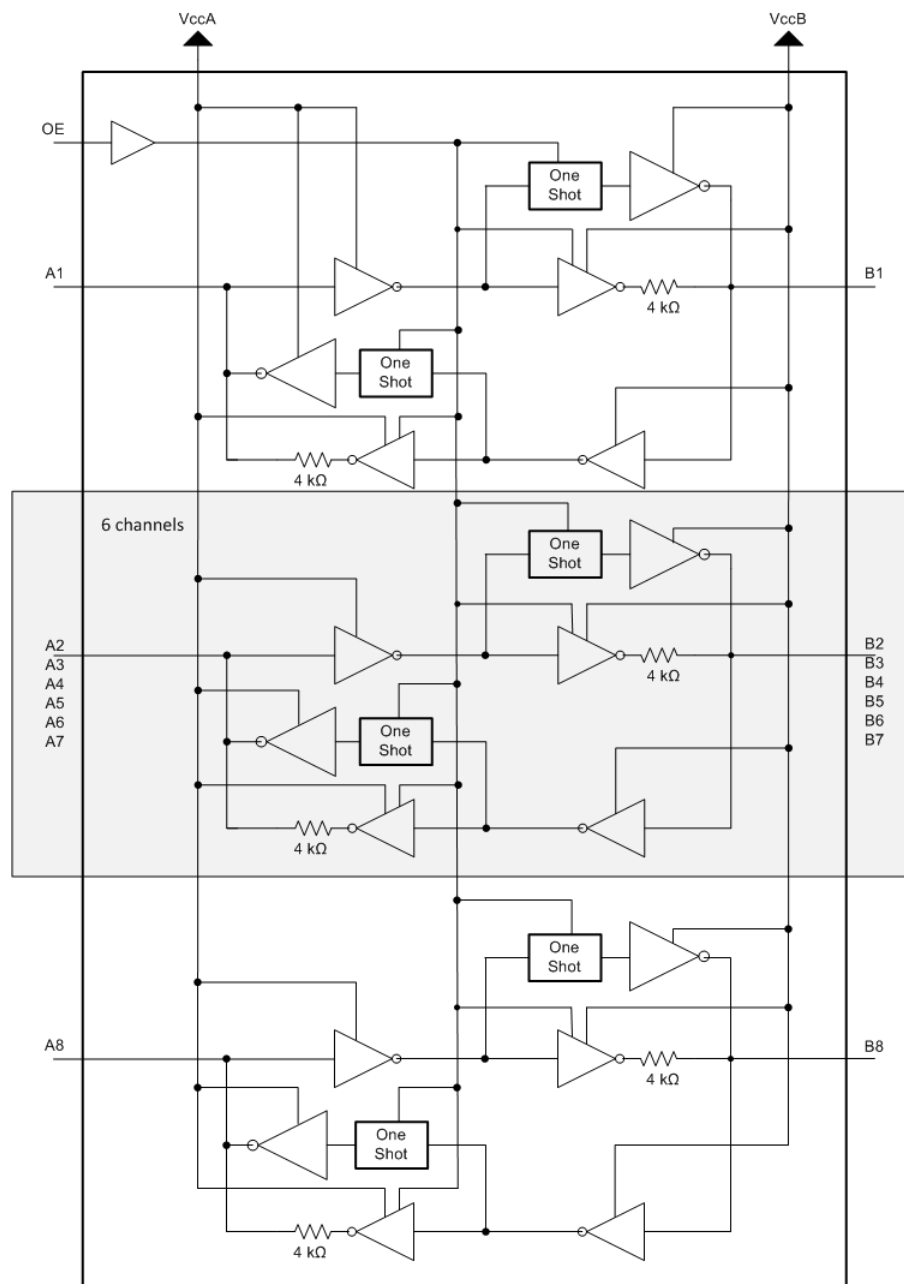
**Figure 6-1. Load Circuits and Voltage Waveforms**

## 7 Detailed Description

### 7.1 Overview

The TXB0108 device is an 8-bit, directionless voltage-level translator specifically designed for translating logic voltage levels. The A port is able to accept I/O voltages ranging from 1.2 V to 3.6 V, while the B port can accept I/O voltages from 1.65 V to 5.5 V. The device is a buffered architecture with edge-rate accelerators (one-shots) to improve the overall data rate. This device can only translate push-pull CMOS logic outputs. If for open-drain signal translation, please refer to TI [TXS](#) products.

### 7.2 Functional Block Diagram

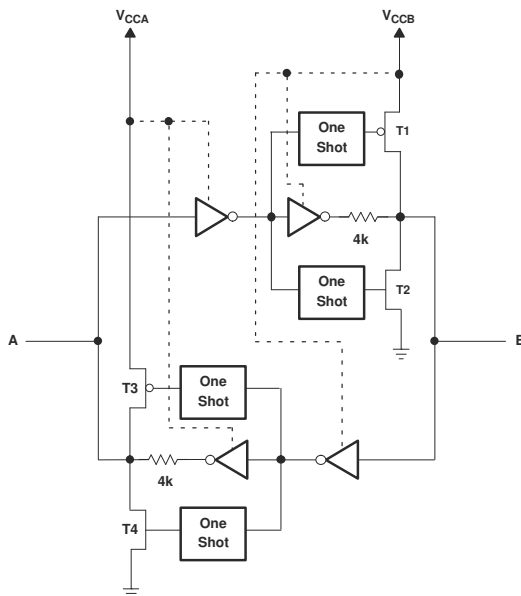




## 7.3 Feature Description

### 7.3.1 Architecture

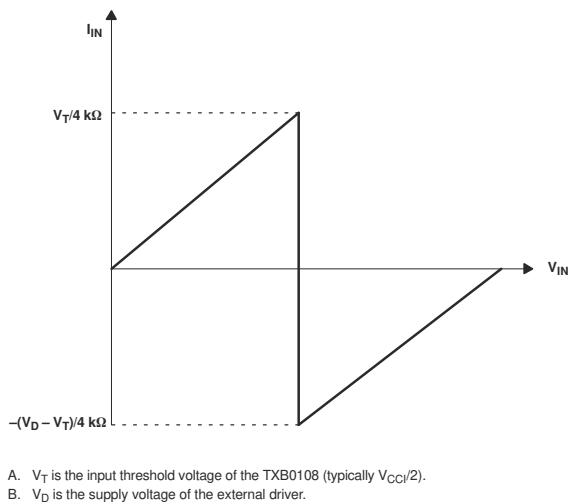
The TXB0108 architecture (see [Figure 7-1](#)) does not require a direction-control signal to control the direction of data flow from A to B or from B to A. In a dc state, the output drivers of the TXB0108 can maintain a high or low, but are designed to be weak so that they can be overdriven by an external driver when data on the bus starts flowing the opposite direction. The output one-shots detect rising or falling edges on the A or B ports. During a rising edge, the one-shot turns on the PMOS transistors (T1, T3) for a short duration, which speeds up the low-to-high transition. Similarly, during a falling edge, the one-shot turns on the NMOS transistors (T2, T4) for a short duration, which speeds up the high-to-low transition. The typical output impedance during output transition is 70  $\Omega$  at VCCO = 1.2 V to 1.8 V, 50  $\Omega$  at VCCO = 1.8 V to 3.3 V and 40  $\Omega$  at VCCO = 3.3 V to 5 V.



**Figure 7-1. Architecture of TXB0108 I/O Cell**

### 7.3.2 Input Driver Requirements

Typical  $I_{IN}$  vs  $V_{IN}$  characteristics of the TXB0108 are shown in [Figure 7-2](#). For proper operation, the device driving the data I/Os of the TXB0108 must have drive strength of at least  $\pm 2$  mA.



**Figure 7-2. Typical  $I_{IN}$  vs  $V_{IN}$  Curve**

### 7.3.3 Output Load Considerations

TI recommends careful PCB layout practices with short PCB trace lengths to avoid excessive capacitive loading and to ensure that proper O.S. triggering takes place. PCB signal trace-lengths should be kept short enough such that the round-trip delay of any reflection is less than the one-shot duration. This improves signal integrity by ensuring that any reflection sees a low impedance at the driver. The O.S. circuits have been designed to stay on for approximately 10 ns. The maximum capacitance of the lumped load that can be driven also depends directly on the one-shot duration. With very heavy capacitive loads, the one-shot can time-out before the signal is driven fully to the positive rail. The O.S. duration has been set to best optimize trade-offs between dynamic ICC, load driving capability, and maximum bit-rate considerations. Both PCB trace length and connectors add to the capacitance that the TXB0108 output sees, so it is recommended that this lumped-load capacitance be considered to avoid O.S. re-triggering, bus contention, output signal oscillations, or other adverse system-level affects.

### 7.3.4 Enable and Disable

The TXB0108 has an OE input that is used to disable the device by setting OE = low, which places all I/Os in the high-impedance (Hi-Z) state. The disable time (t<sub>dis</sub>) indicates the delay between when OE goes low and when the outputs actually get disabled (Hi-Z). The enable time (t<sub>en</sub>) indicates the amount of time the user must allow for the one-shot circuitry to become operational after the OE is high.

### 7.3.5 Pullup or Pulldown Resistors on I/O Lines

The TXB0108 is designed to drive capacitive loads of up to 70 pF. The output drivers of the TXB0108 have low dc drive strength. If pullup or pulldown resistors are connected externally to the data I/Os, their values must be kept higher than 50 k $\Omega$  to ensure that they do not contend with the output drivers of the TXB0108. For the same reason, the TXB0108 should not be used in applications such as I2C or 1-Wire where an open-drain driver is connected on the bidirectional data I/O. For these applications, use a device from the TI TXS01xx series of level translators.

## 7.4 Device Functional Modes

The TXB0108 device has two functional modes, enabled and disabled. To disable the device, set the OE input low, which places all I/Os in a high impedance state. Setting the OE input high will enable the device.

## 8 Application and Implementation

### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### 8.1 Application Information

The TXB0108 can be used in level-translation applications for interfacing devices or systems operating at different interface voltages with one another. It can only translate push-pull CMOS logic outputs. If for open-drain signal translation, please refer to TI TXS010X products. Any external pulldown or pullup resistors are recommended to be larger than 50kΩ.

### 8.2 Typical Application

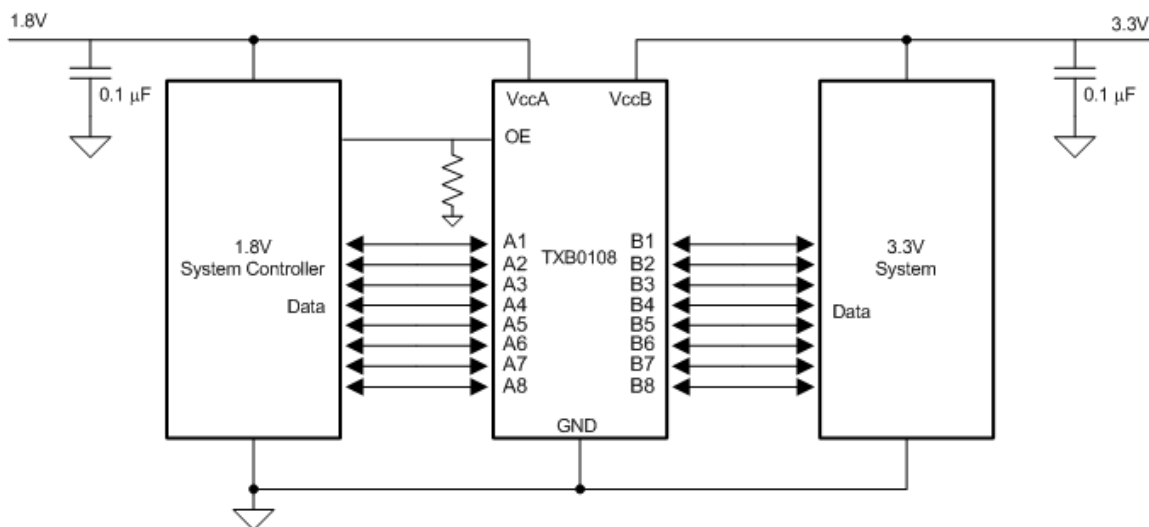


Figure 8-1. Typical Operating Circuit

#### 8.2.1 Design Requirements

For this design example, use the parameters listed in [Table 8-1](#). Make sure the  $V_{CCA} \leq V_{CCB}$ .

Table 8-1. Design Parameters

| DESIGN PARAMETER     | EXAMPLE VALUE   |
|----------------------|-----------------|
| Input voltage range  | 1.2 V to 3.6 V  |
| Output voltage range | 1.65 V to 5.5 V |

#### 8.2.2 Detailed Design Procedure

To begin the design process, determine the following:

- Input voltage range
  - Use the supply voltage of the device that is driving the TXB0108 device to determine the input voltage range. For a valid logic high the value must exceed the  $V_{IH}$  of the input port. For a valid logic low, the value must be less than the  $V_{IL}$  of the input port.
- Output voltage range

- Use the supply voltage of the device that the TXB0108 device is driving to determine the output voltage range.
- Do not recommend having the external pullup or pulldown resistors. If mandatory, it is recommended the value should be larger than 50 kΩ.
- An external pulldown or pullup resistor decreases the output  $V_{OH}$  and  $V_{OL}$ . Use the below equations to draft estimate the  $V_{OH}$  and  $V_{OL}$  as a result of an external pulldown and pullup resistor.

$$V_{OH} = V_{CCx} \times R_{PD} / (R_{PD} + 4.5 \text{ k}\Omega)$$

$$V_{OL} = V_{CCx} \times 4.5 \text{ k}\Omega / (R_{PU} + 4.5 \text{ k}\Omega)$$

Where:

- $V_{CCx}$  is the output port supply voltage on either VCCA or VCCB
- $R_{PD}$  is the value of the external pull down resistor
- $R_{PU}$  is the value of the external pull up resistor
- 4.5 kΩ is the counting the variation of the serial resistor 4 kΩ in the I/O line. Refer to the [Effects of external pullup and pulldown resistors on TXB](#) application note

### 8.2.3 Application Curves

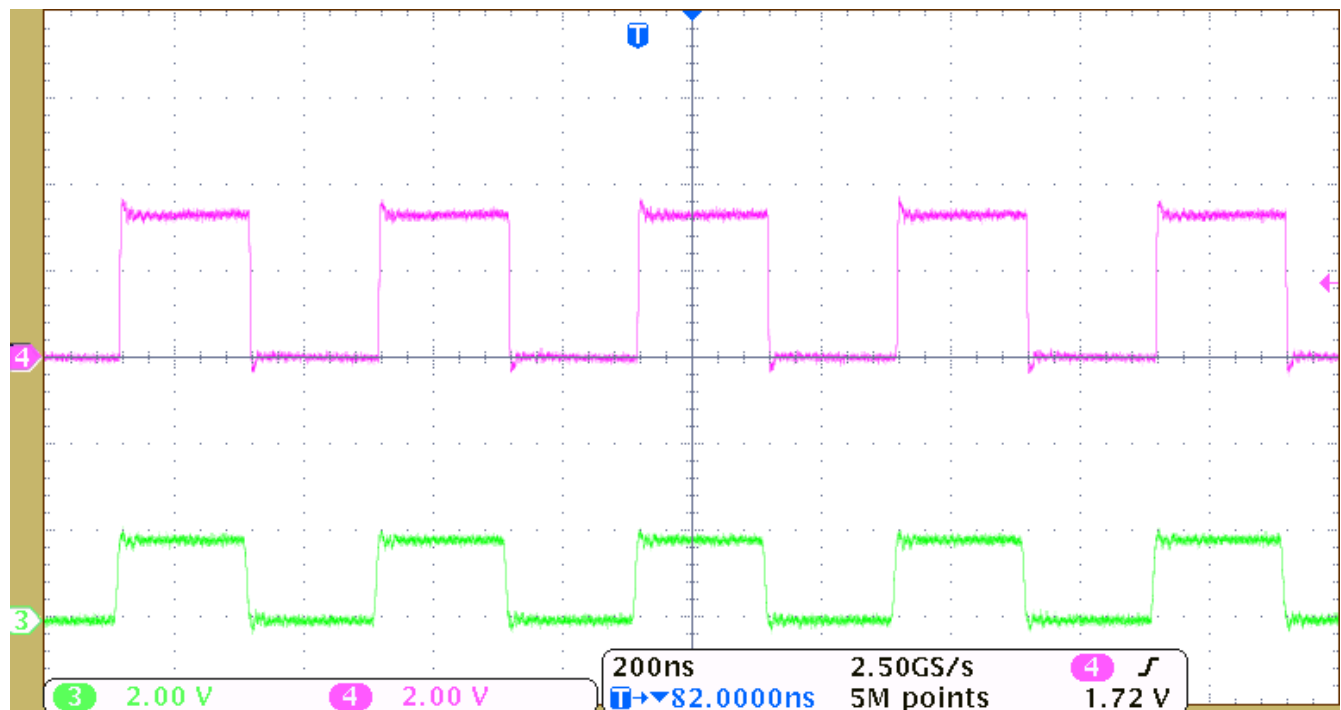


Figure 8-2. Level-Translation of a 2.5-MHz Signal

## 9 Power Supply Recommendations

During operation, ensure that  $V_{CCA} \leq V_{CCB}$  at all times. During power-up sequencing,  $V_{CCA} \geq V_{CCB}$  does not damage the device, so any power supply can be ramped up first. The TXB0108-Q1 has circuitry that disables all output ports when either VCC is switched off ( $V_{CCA/B} = 0$  V).

The output-enable (OE) input circuit is designed so that it is supplied by  $V_{CCA}$  and when the (OE) input is low, all outputs are placed in the high-impedance state. To ensure the high-impedance state of the outputs during power-up or power-down, the OE input pin must be tied to GND through a pulldown resistor and must not be enabled until  $V_{CCA}$  and  $V_{CCB}$  are fully ramped and stable. The minimum value of the pulldown resistor to ground is determined by the current-sourcing capability of the driver.

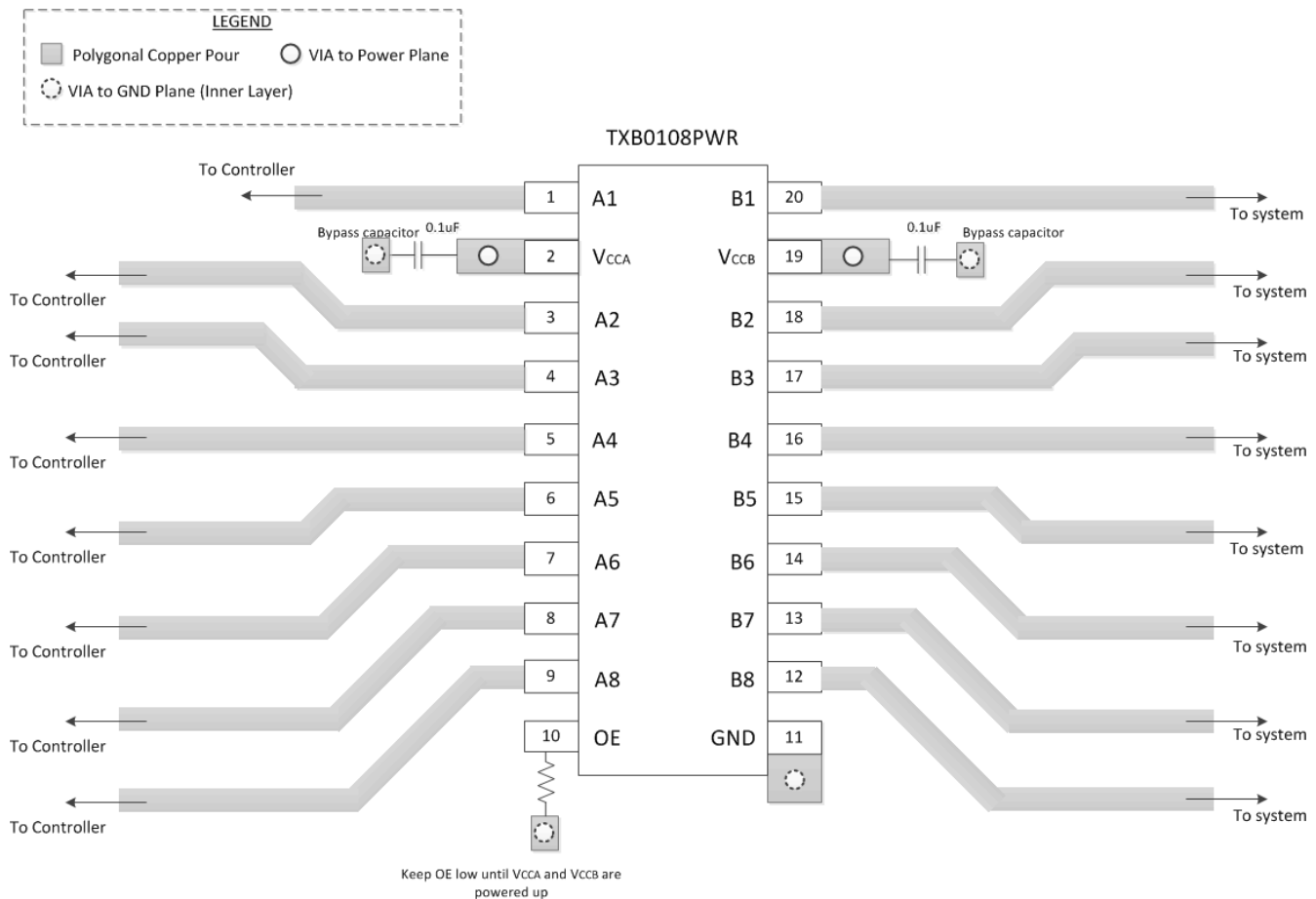
## 10 Layout

### 10.1 Layout Guidelines

To ensure reliability of the device, the following common printed-circuit board layout guidelines is recommended.

- Bypass capacitors should be used on power supplies and should be placed as close as possible to the  $V_{CCA}$ ,  $V_{CCB}$  pin and GND pin.
- Short trace lengths should be used to avoid excessive loading.
- PCB signal trace-lengths must be kept short enough so that the round-trip delay of any reflection is less than the one-shot duration, approximately 10 ns, ensuring that any reflection encounters low impedance at the source driver.

### 10.2 Layout Example



## 11 Device and Documentation Support

### 11.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](http://ti.com). Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 11.2 Support Resources

TI E2E™ support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

### 11.3 Trademarks

TI E2E™ is a trademark of Texas Instruments.

All trademarks are the property of their respective owners.

### 11.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 11.5 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

## 12 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

### Changes from Revision I (December 2024) to Revision J (February 2025) Page

- Added DGS and RKS package options to *Device Information* table..... 1
- Updated thermal information for RUK, DGS and RKS packages..... 7

### Changes from Revision H (August 2020) to Revision I (December 2024) Page

- Added RUK package option to *Device Information* table..... 1

### Changes from Revision G (December 2018) to Revision H (August 2020) Page

- Updated the numbering format for tables, figures and cross-references throughout the document..... 1
- Added NME package option to *Device Information* table..... 1
- Added NME package to *Pin Assignments* table..... 3

### Changes from Revision F (November 2014) to Revision G (December 2018) Page

- Added pinout image for the ZYPR2 package option ..... 3
- Added text string 'GRID LOCATOR' to Pin Functions table YZP column to clarify pin location from 'Signal Name' ..... 3

| <b>Changes from Revision E (April 2012) to Revision F (October 2014)</b>                                                                                                                                                                                                                                                                                                                                                                                | <b>Page</b> |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------|
| <ul style="list-style-type: none"> <li>Added <i>Pin Configuration and Functions</i> section, <i>Handling Rating</i> table, <i>Feature Description</i> section, <i>Device Functional Modes</i>, <i>Application and Implementation</i> section, <i>Power Supply Recommendations</i> section, <i>Layout</i> section, <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section .....</li> </ul> | 1           |

| <b>Changes from Revision D (September 2011) to Revision E (April 2012)</b>             | <b>Page</b> |
|----------------------------------------------------------------------------------------|-------------|
| <ul style="list-style-type: none"> <li>Added notes to pin out graphics.....</li> </ul> | 3           |

| <b>Changes from Revision C (August 2011) to Revision D (September 2011)</b>                                                                 | <b>Page</b> |
|---------------------------------------------------------------------------------------------------------------------------------------------|-------------|
| <ul style="list-style-type: none"> <li>Added <math>\pm 8</math>-kV Human-Body Model (A114-B) (YZP Package Only) to Features.....</li> </ul> | 1           |

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type               | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|----------------------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| TXB0108DGSR      | ACTIVE        | VSSOP                      | DGS                | 20   | 5000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | YE08                    | <a href="#">Samples</a> |
| TXB0108DQSR      | ACTIVE        | USON                       | DQS                | 20   | 3000           | RoHS & Green    | NIPDAUAG                             | Level-1-260C-UNLIM   | -40 to 85    | 5MR<br>5MH              | <a href="#">Samples</a> |
| TXB0108NMER      | ACTIVE        | NFBGA                      | NME                | 20   | 2500           | RoHS & Green    | SNAGCU                               | Level-2-260C-1 YEAR  | -40 to 85    | 29WW                    | <a href="#">Samples</a> |
| TXB0108PWR       | ACTIVE        | TSSOP                      | PW                 | 20   | 2000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | YE08                    | <a href="#">Samples</a> |
| TXB0108PWRG4     | ACTIVE        | TSSOP                      | PW                 | 20   | 2000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | YE08                    | <a href="#">Samples</a> |
| TXB0108RGYR      | ACTIVE        | VQFN                       | RGY                | 20   | 3000           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 85    | YE08                    | <a href="#">Samples</a> |
| TXB0108YZPR      | ACTIVE        | DSBGA                      | YZP                | 20   | 3000           | RoHS & Green    | SNAGCU                               | Level-1-260C-UNLIM   | -40 to 85    | 5M                      | <a href="#">Samples</a> |
| TXB0108YZPR2     | ACTIVE        | DSBGA                      | YZP                | 20   | 3000           | RoHS & Green    | SNAGCU                               | Level-1-260C-UNLIM   | -40 to 85    | EK                      | <a href="#">Samples</a> |
| TXB0108ZXYR      | OBSOLETE      | BGA<br>MICROSTAR<br>JUNIOR | ZXY                | 20   |                | TBD             | Call TI                              | Call TI              | -40 to 85    |                         |                         |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.



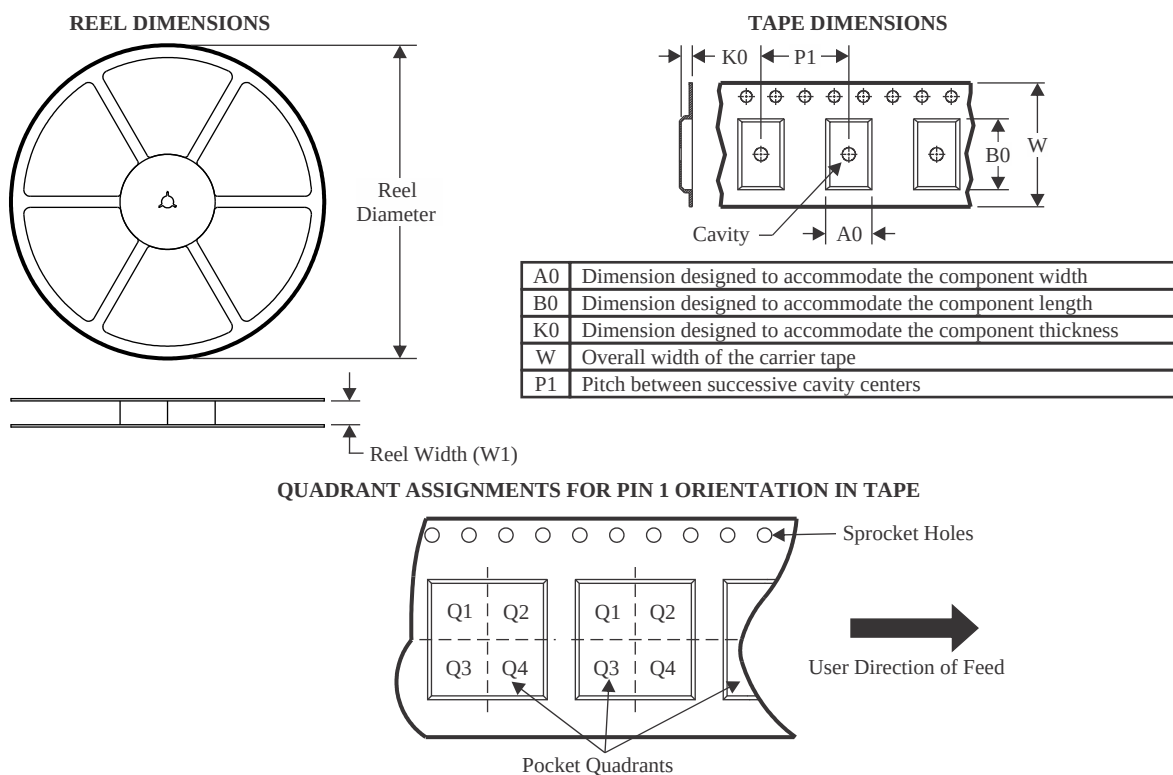
<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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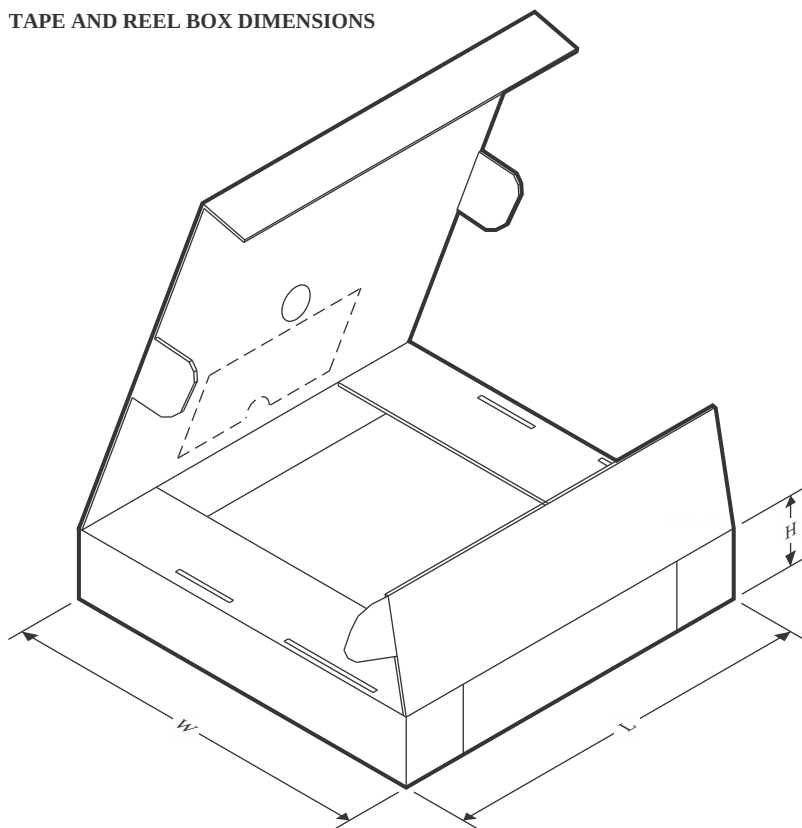
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TXB0108DGSR  | VSSOP        | DGS             | 20   | 5000 | 330.0              | 16.4               | 5.4     | 5.4     | 1.45    | 8.0     | 16.0   | Q1            |
| TXB0108DQSR  | USON         | DQS             | 20   | 3000 | 177.8              | 12.4               | 2.21    | 4.22    | 0.81    | 4.0     | 12.0   | Q1            |
| TXB0108NMER  | NFBGA        | NME             | 20   | 2500 | 330.0              | 12.4               | 2.85    | 3.4     | 1.34    | 4.0     | 12.0   | Q2            |
| TXB0108PWR   | TSSOP        | PW              | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.0     | 1.4     | 8.0     | 16.0   | Q1            |
| TXB0108RGYR  | VQFN         | RGY             | 20   | 3000 | 330.0              | 12.4               | 3.8     | 4.8     | 1.6     | 8.0     | 12.0   | Q1            |
| TXB0108YZPR  | DSBGA        | YZP             | 20   | 3000 | 180.0              | 8.4                | 1.99    | 2.49    | 0.56    | 4.0     | 8.0    | Q1            |
| TXB0108YZPR2 | DSBGA        | YZP             | 20   | 3000 | 180.0              | 8.4                | 1.99    | 2.49    | 0.56    | 4.0     | 8.0    | Q2            |

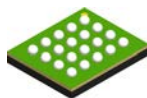
## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TXB0108DGSR  | VSSOP        | DGS             | 20   | 5000 | 353.0       | 353.0      | 32.0        |
| TXB0108DQSR  | USON         | DQS             | 20   | 3000 | 202.0       | 201.0      | 28.0        |
| TXB0108NMER  | NFBGA        | NME             | 20   | 2500 | 336.6       | 336.6      | 31.8        |
| TXB0108PWR   | TSSOP        | PW              | 20   | 2000 | 356.0       | 356.0      | 35.0        |
| TXB0108RGYR  | VQFN         | RGY             | 20   | 3000 | 356.0       | 356.0      | 35.0        |
| TXB0108YZPR  | DSBGA        | YZP             | 20   | 3000 | 182.0       | 182.0      | 20.0        |
| TXB0108YZPR2 | DSBGA        | YZP             | 20   | 3000 | 182.0       | 182.0      | 20.0        |

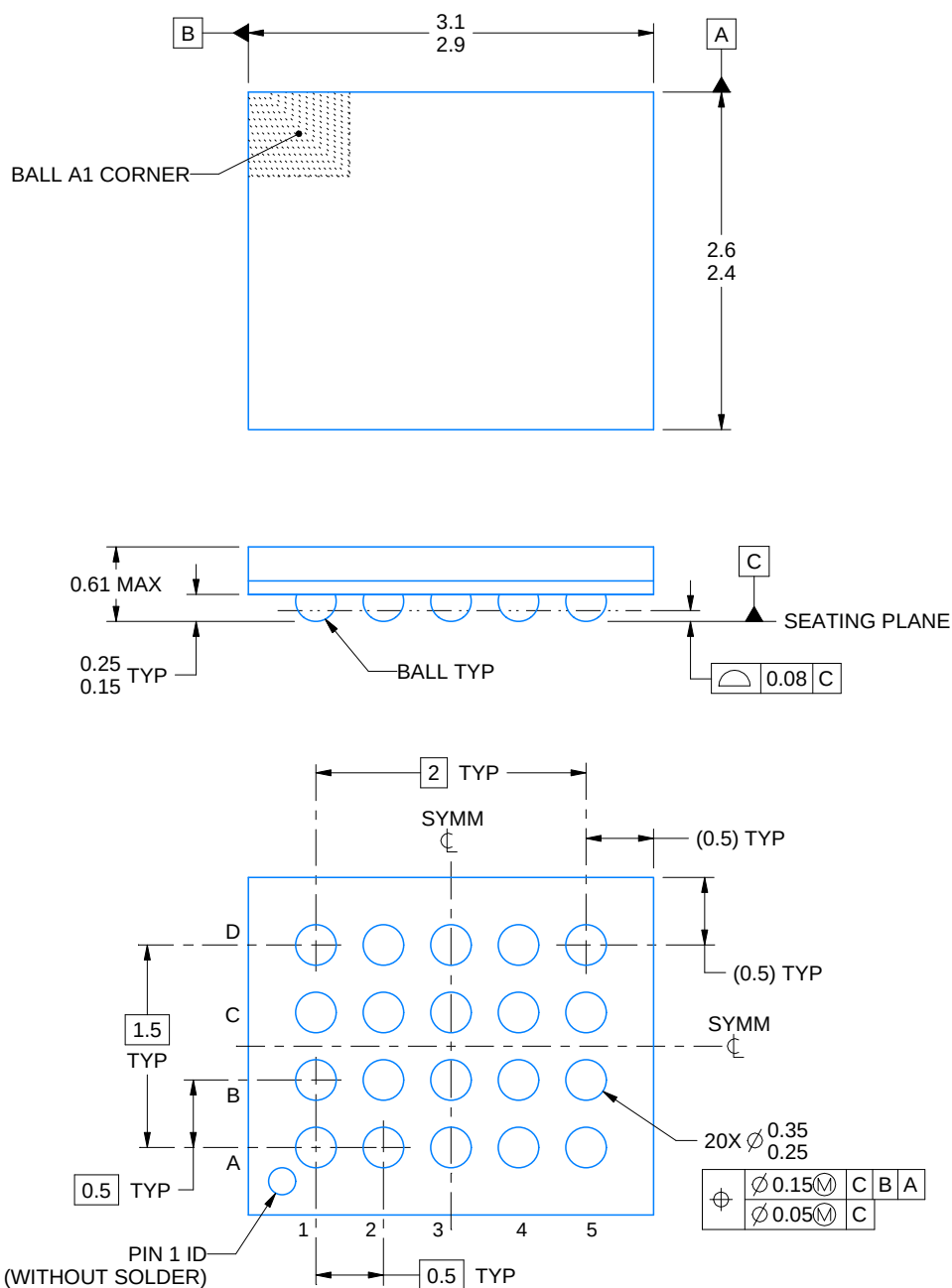
ZXY0020A



## PACKAGE OUTLINE

VFBGA - 0.61 mm max height

PLASTIC BALL GRID ARRAY



4222996/A 12/2016

### NOTES:

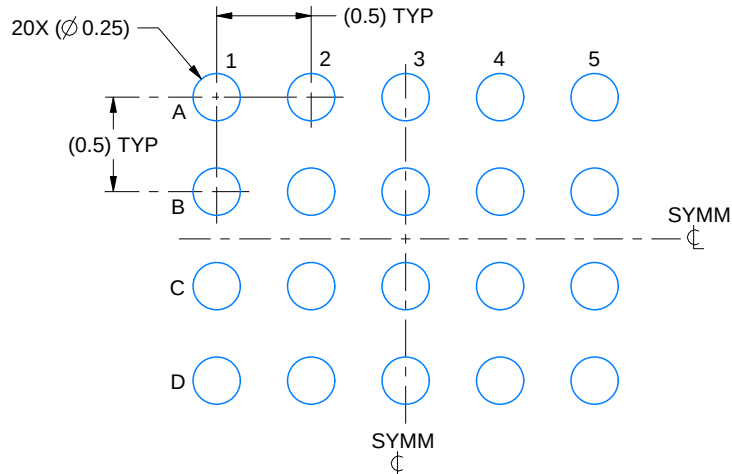
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

# EXAMPLE BOARD LAYOUT

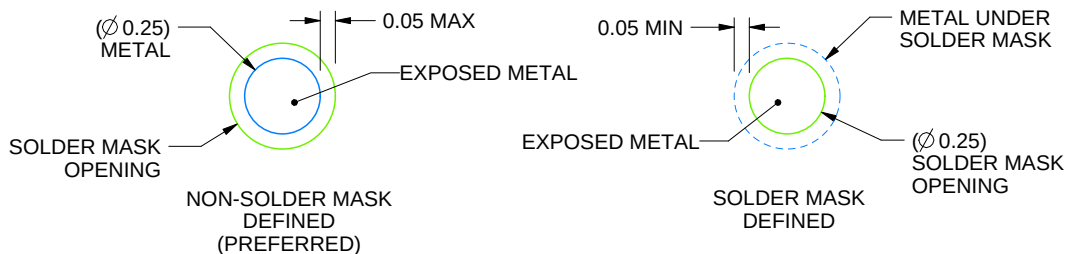
ZXY0020A

VFBGA - 0.61 mm max height

PLASTIC BALL GRID ARRAY



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:25X



SOLDER MASK DETAILS  
NOT TO SCALE

4222996/A 12/2016

NOTES: (continued)

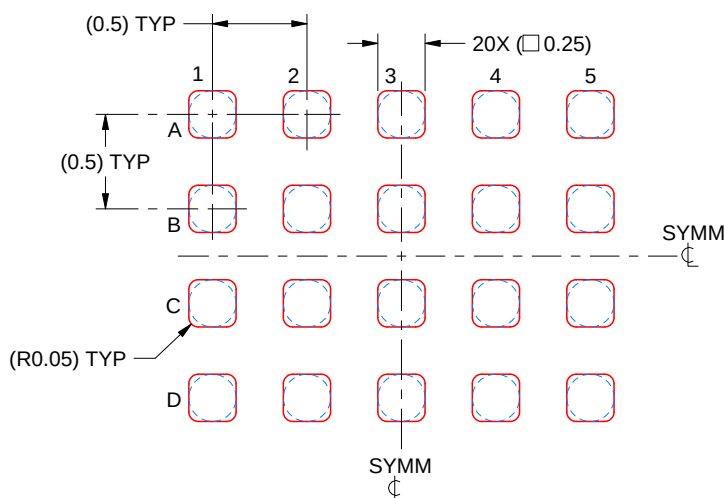
- Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For information, see Texas Instruments literature number SPRAA99 ([www.ti.com/lit/spraa99](http://www.ti.com/lit/spraa99)).

## EXAMPLE STENCIL DESIGN

ZXY0020A

VFBGA - 0.61 mm max height

PLASTIC BALL GRID ARRAY

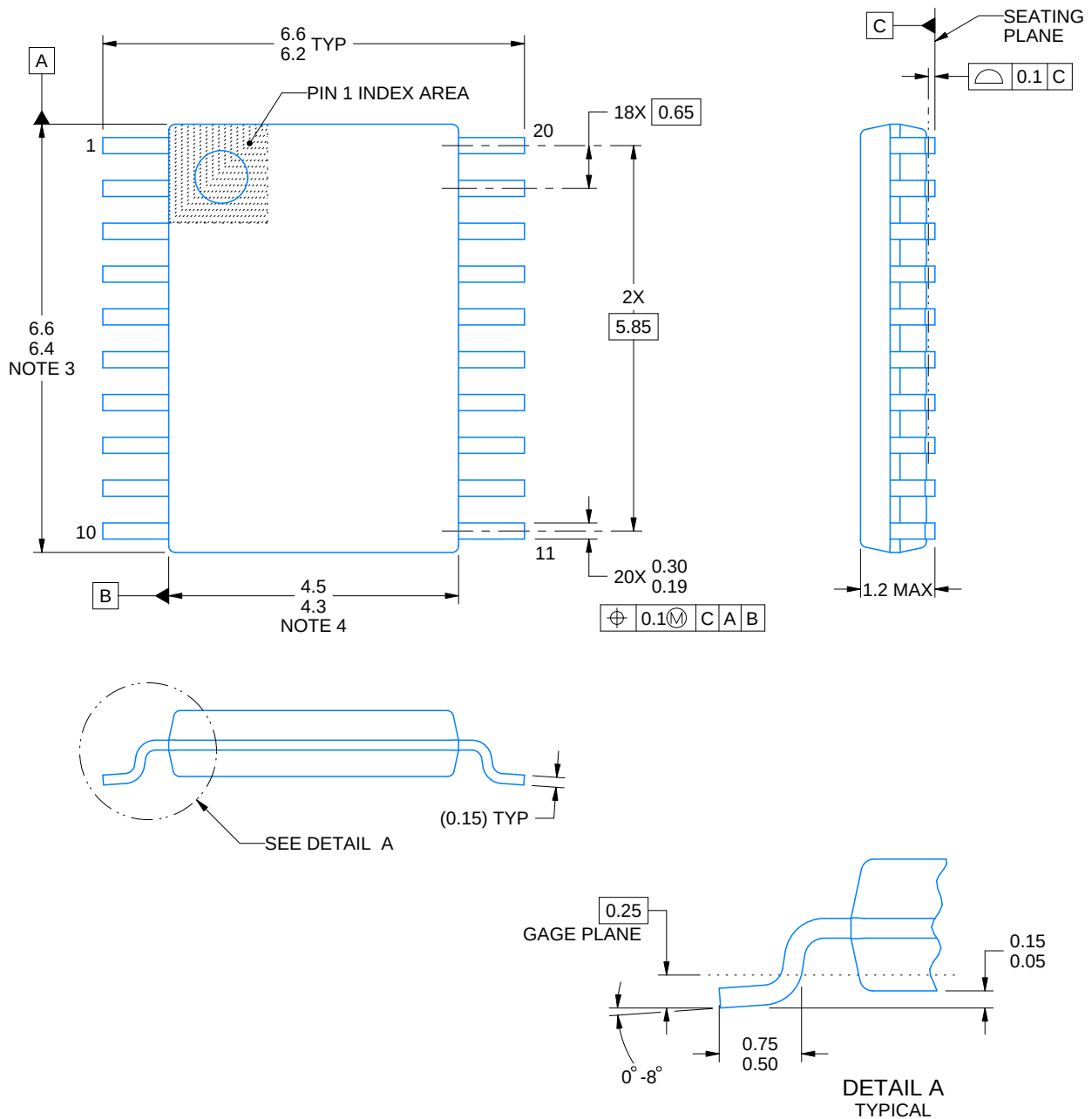
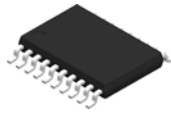


SOLDER PASTE EXAMPLE  
BASED ON 0.1 mm THICK STENCIL  
SCALE: 25X

4222996/A 12/2016

NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.



4220206/A 02/2017

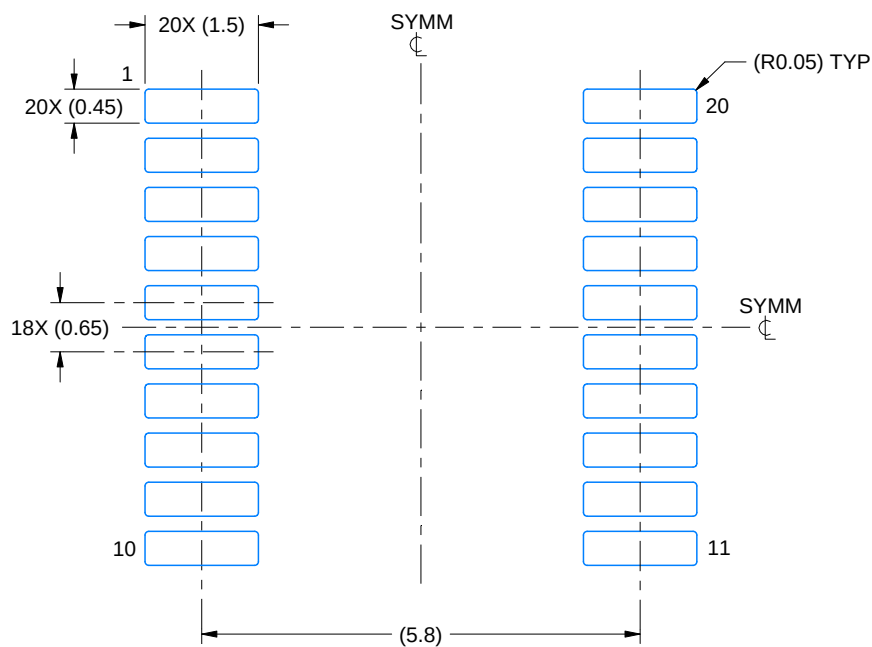
## NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

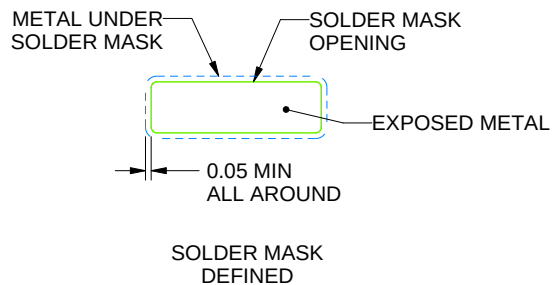
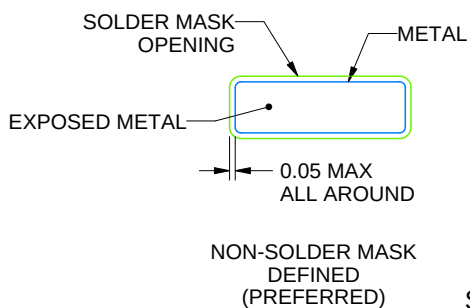
**PW0020A**

**TSSOP - 1.2 mm max height**

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



## SOLDER MASK DETAILS

4220206/A 02/2017

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.  
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

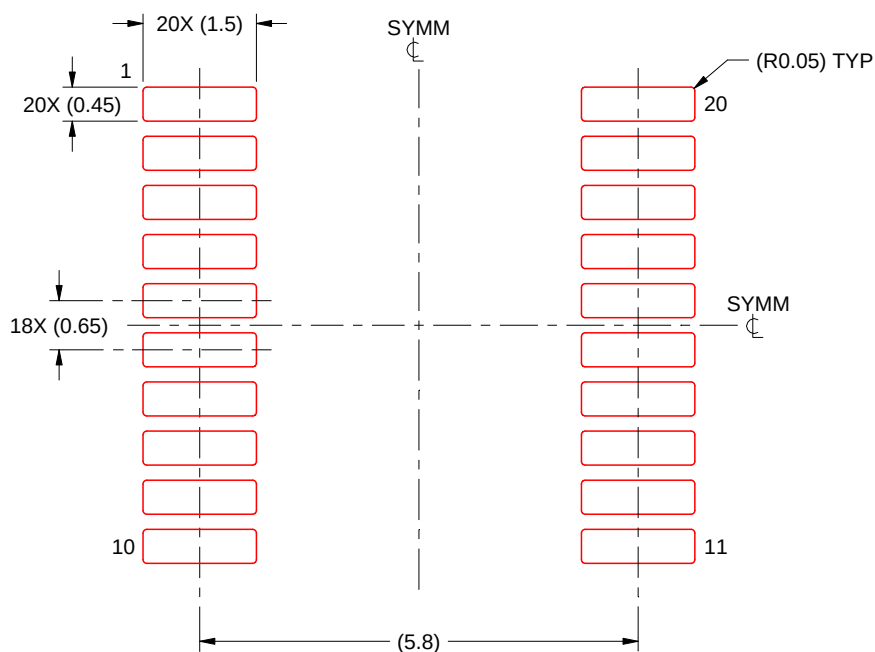


## EXAMPLE STENCIL DESIGN

PW0020A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE

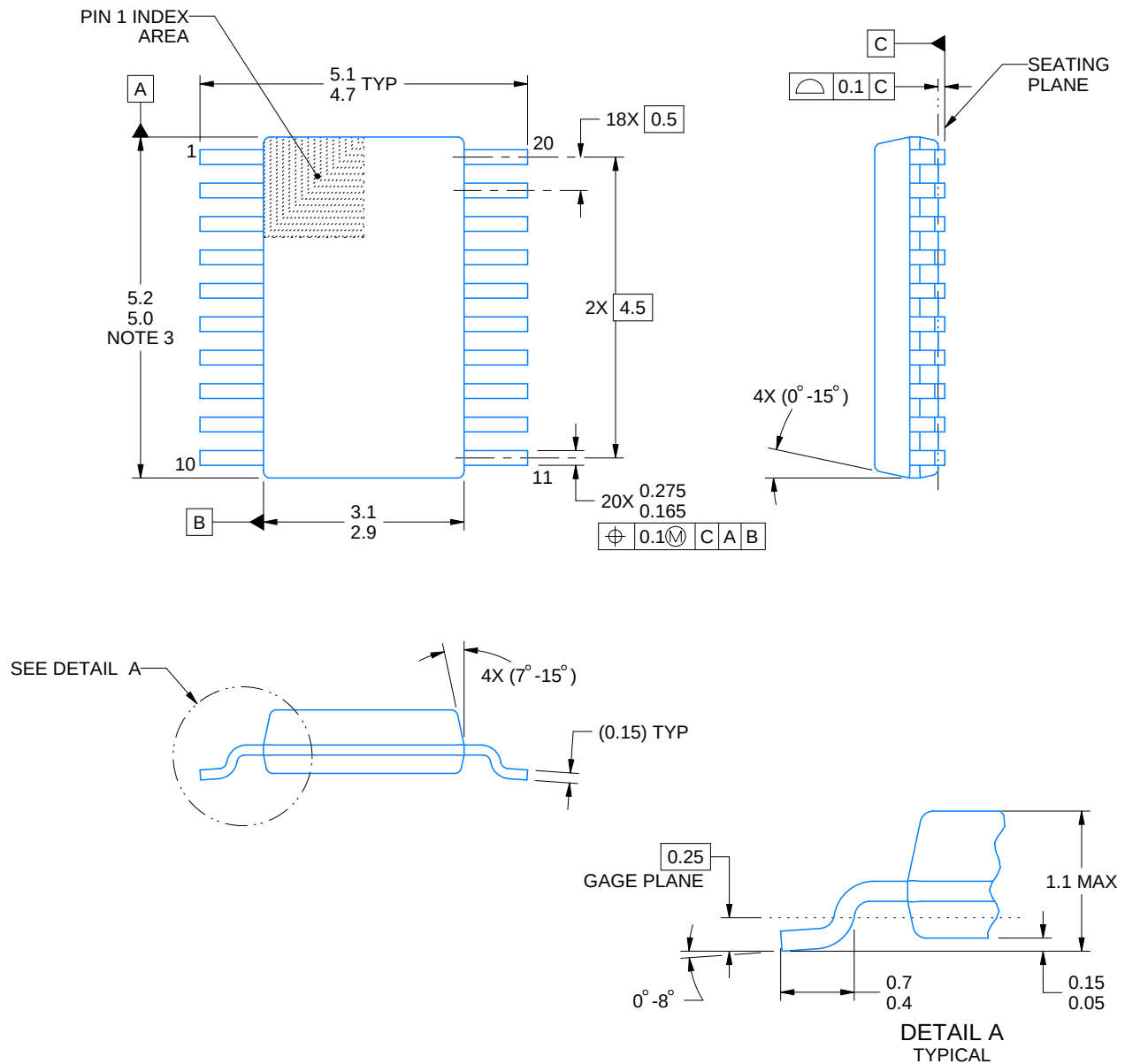


SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4220206/A 02/2017

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.



4226367/A 10/2020

## NOTES:

PowerPAD is a trademark of Texas Instruments.

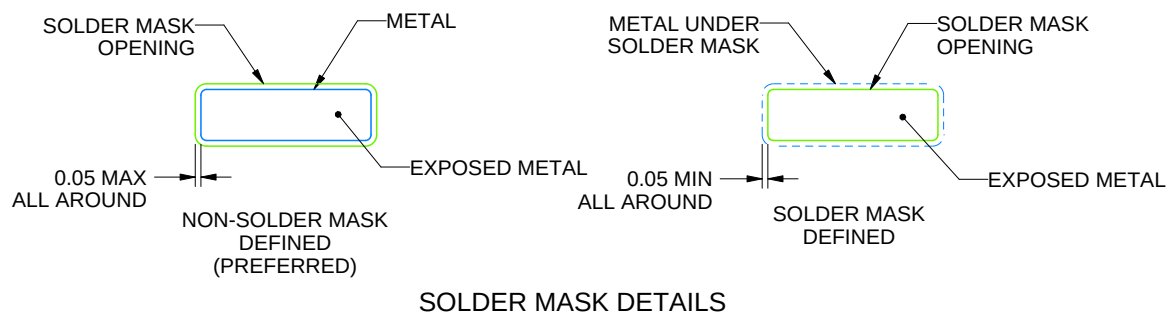
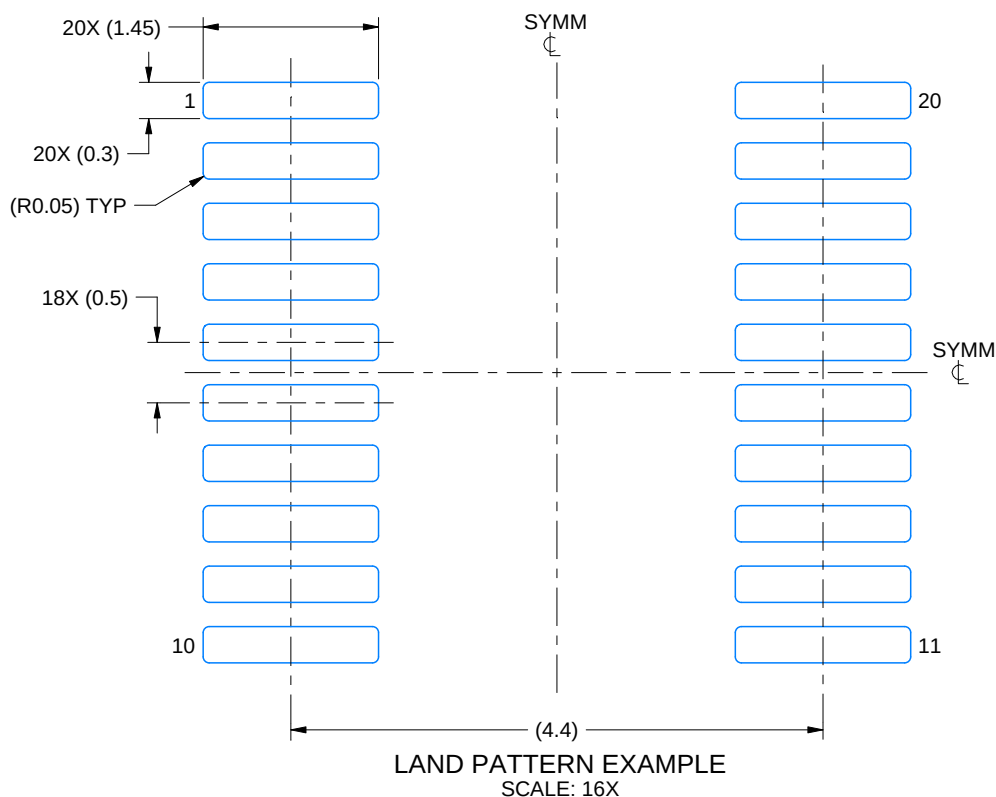
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. No JEDEC registration as of September 2020.
5. Features may differ or may not be present.

# EXAMPLE BOARD LAYOUT

DGS0020A

VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE



4226367/A 10/2020

NOTES: (continued)

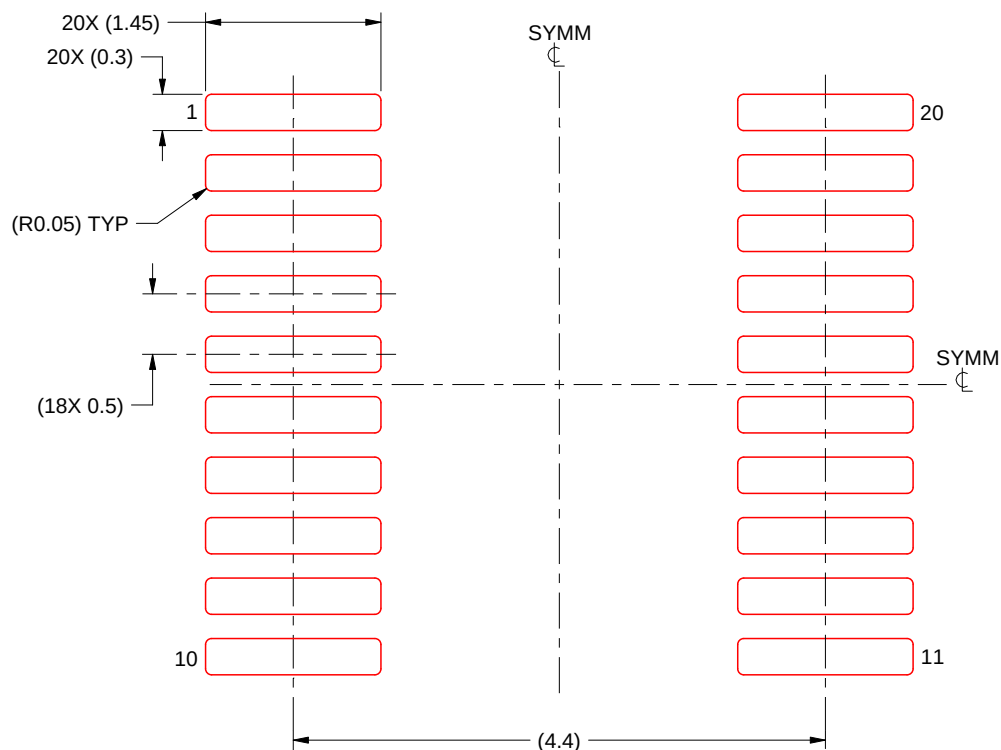
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
8. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature numbers SLMA002 ([www.ti.com/lit/slma002](http://www.ti.com/lit/slma002)) and SLMA004 ([www.ti.com/lit/slma004](http://www.ti.com/lit/slma004)).
9. Size of metal pad may vary due to creepage requirement.
10. Vias are optional depending on application, refer to device data sheet. It is recommended that vias under paste be filled, plugged or tented.

# EXAMPLE STENCIL DESIGN

DGS0020A

VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 16X

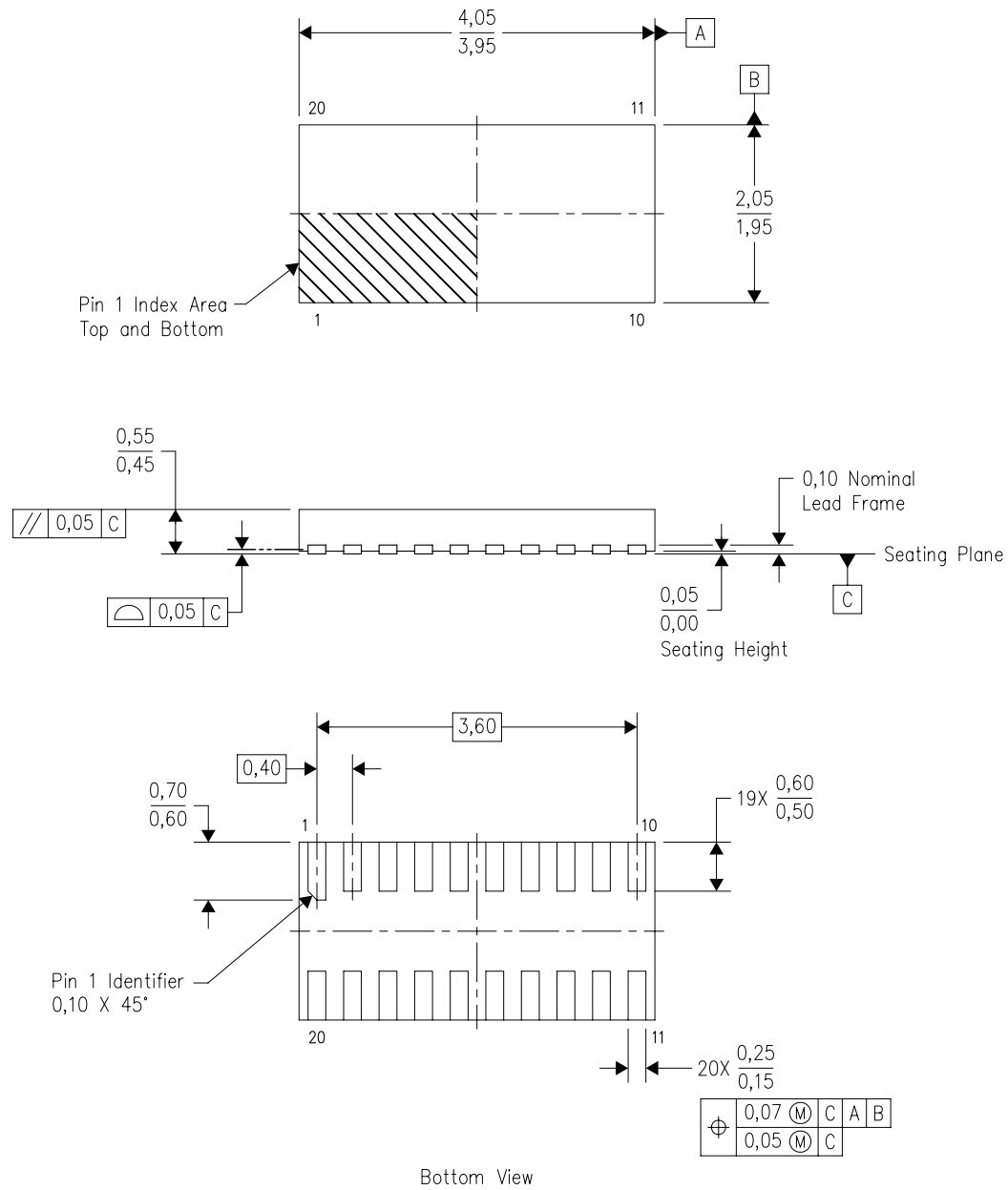
4226367/A 10/2020

NOTES: (continued)

11. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
12. Board assembly site may have different recommendations for stencil design.

DQS (R-PUSON-N20)

PLASTIC SMALL OUTLINE NO-LEAD

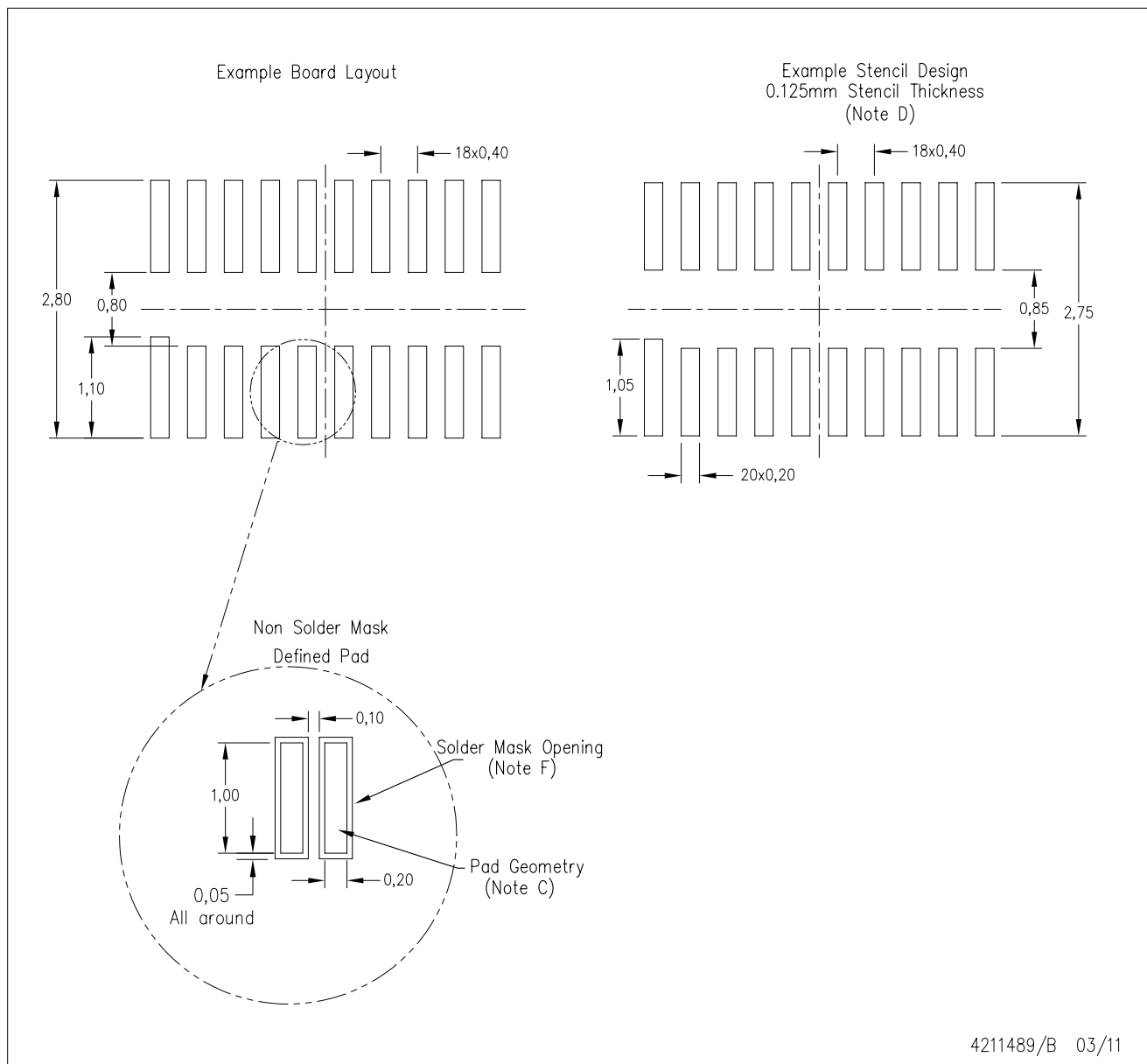


4210558/B 03/11

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. SON (Small Outline No-Lead) package configuration.

DQS (R-PUSON-N20)

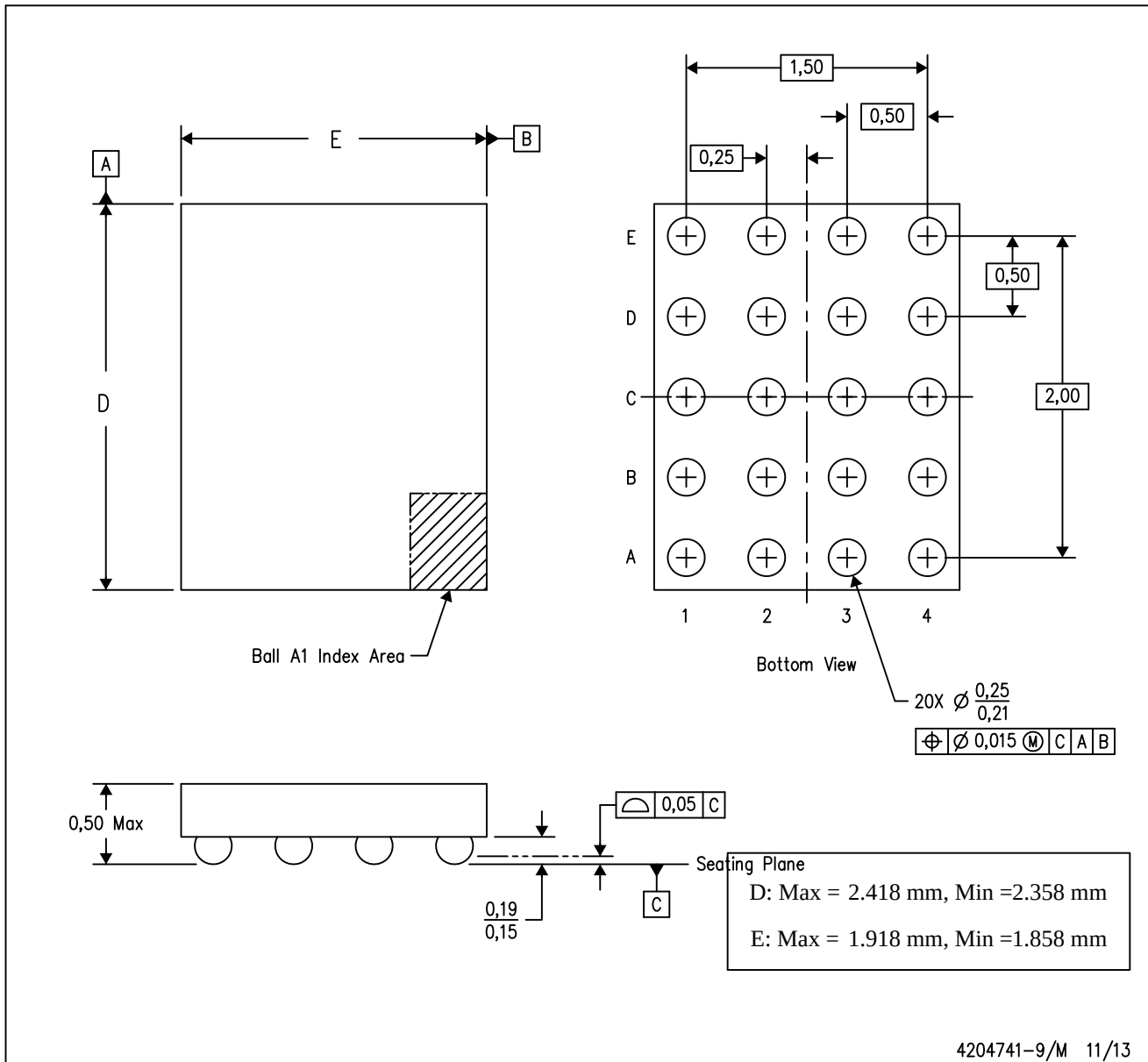
PLASTIC SMALL OUTLINE NO-LEAD



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
  - E. Customers should contact their board fabrication site for minimum solder mask web tolerances between signal pads.

YZP (R-XBGA-N20)

DIE-SIZE BALL GRID ARRAY



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. NanoFree™ package configuration.

## GENERIC PACKAGE VIEW

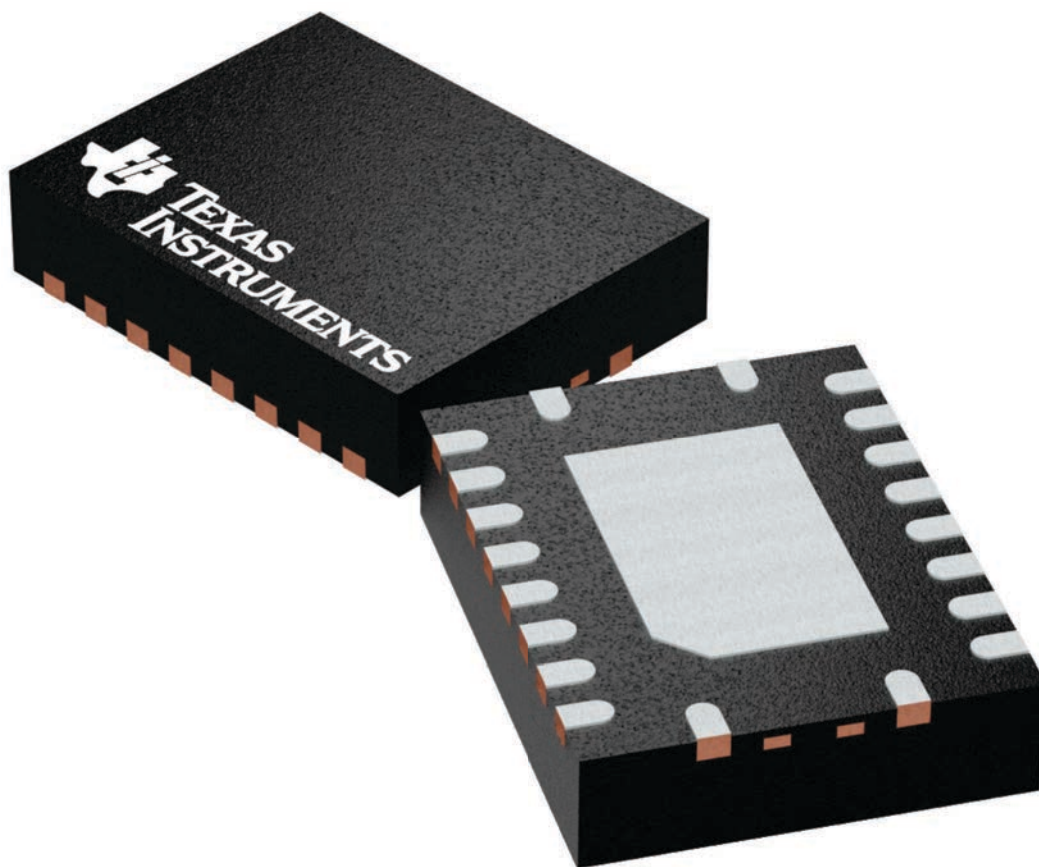
**RGY 20**

**VQFN - 1 mm max height**

3.5 x 4.5, 0.5 mm pitch

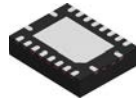
PLASTIC QUAD FGLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.





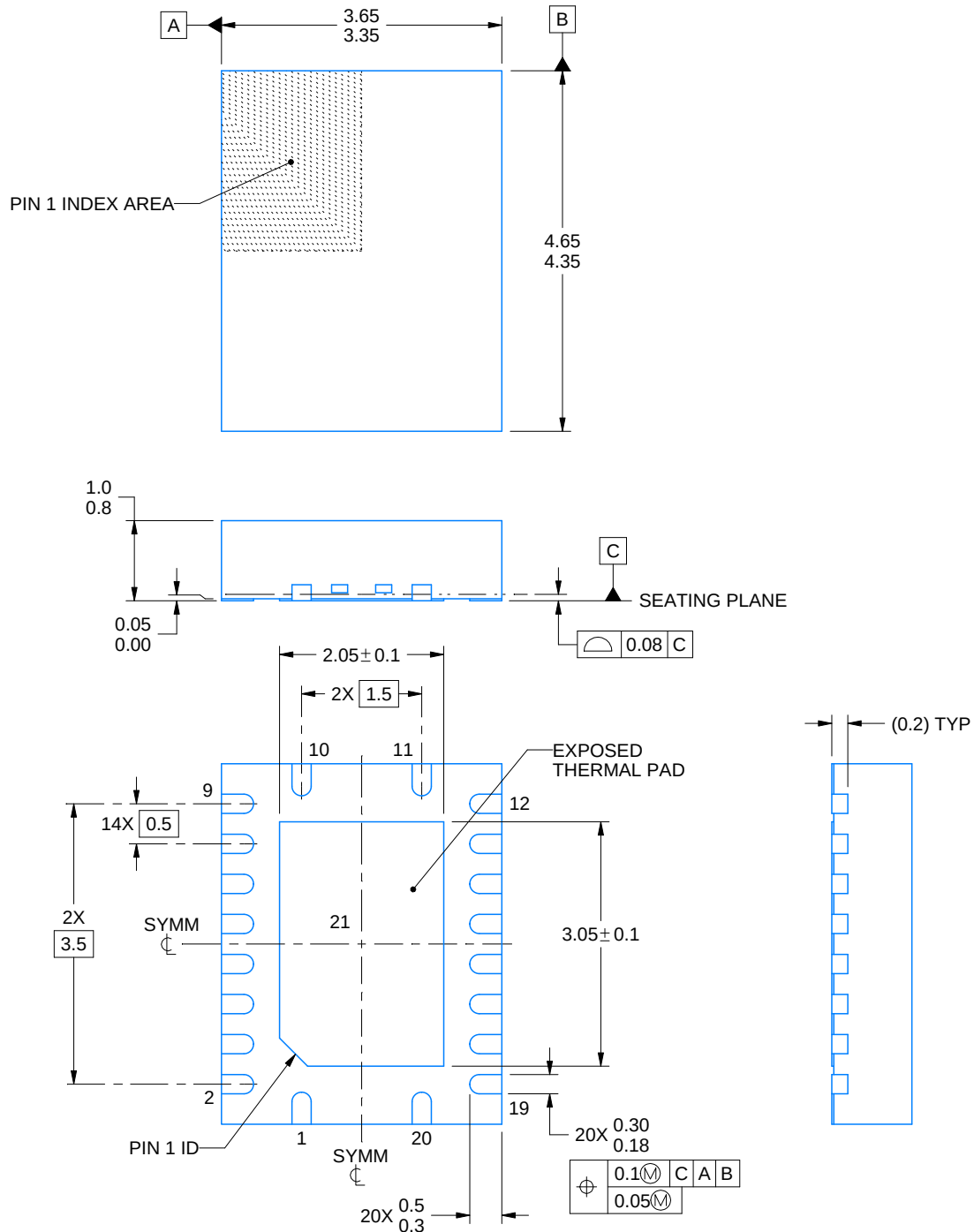
RGY0020A



## PACKAGE OUTLINE

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



4225320/A 09/2019

### NOTES:

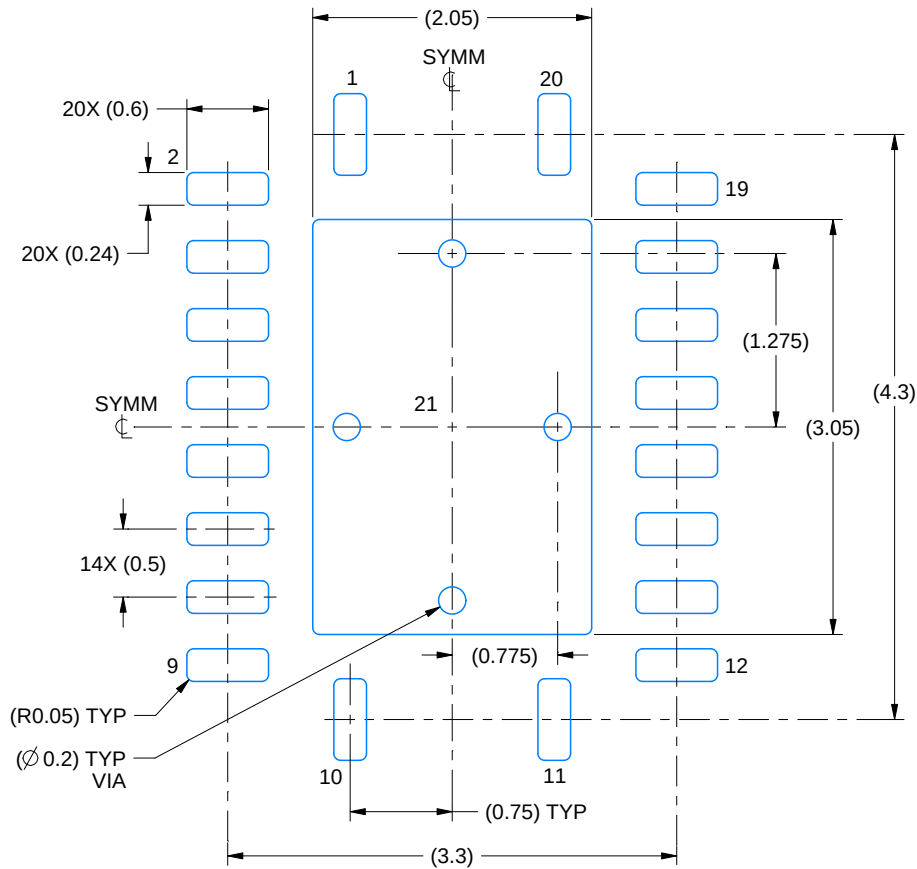
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

# EXAMPLE BOARD LAYOUT

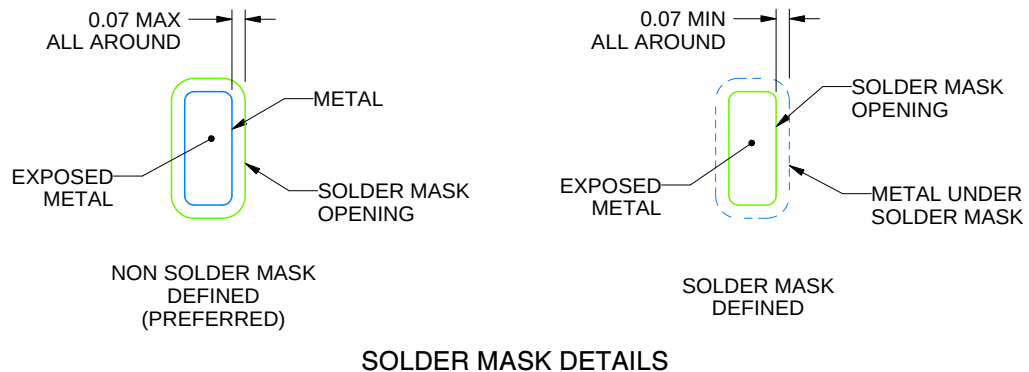
RGY0020A

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



**LAND PATTERN EXAMPLE**  
EXPOSED METAL SHOWN  
SCALE:18X



4225320/A 09/2019

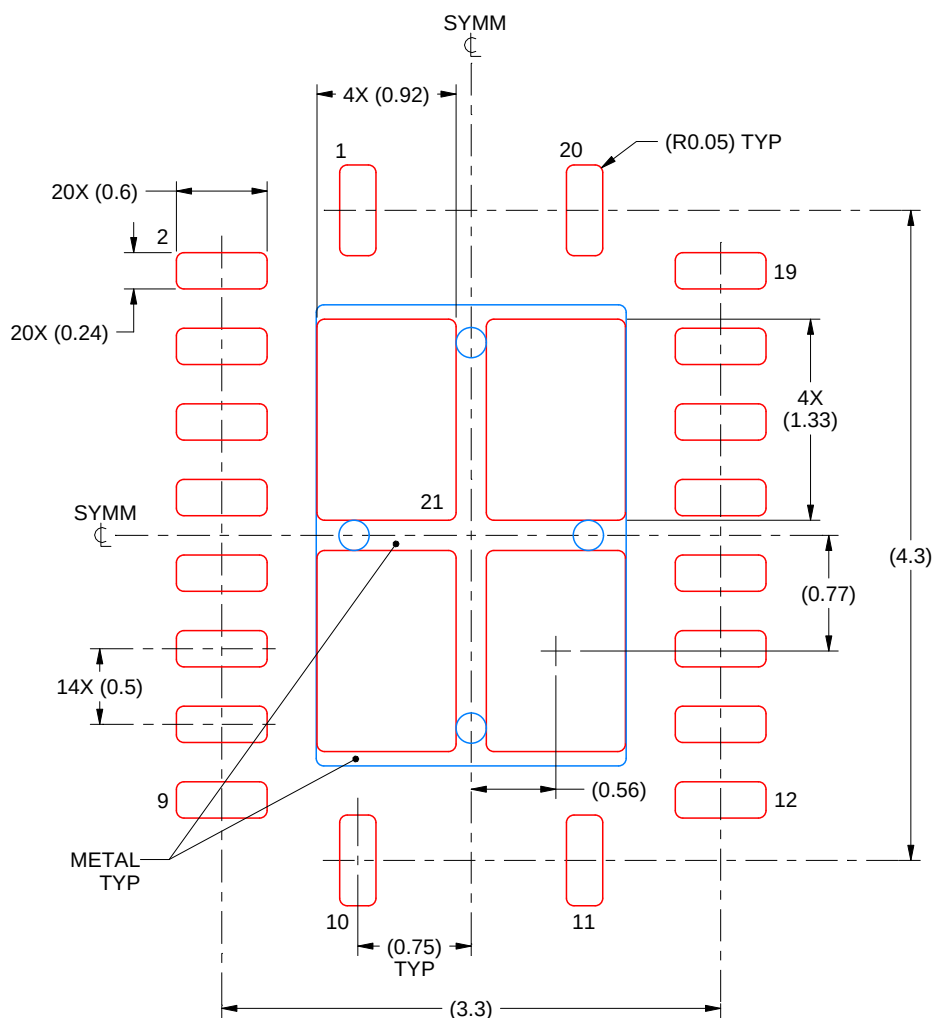
NOTES: (continued)

- This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/slua271](http://www.ti.com/lit/slua271)).
- Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

**RGY0020A**

**VQFN - 1 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



## SOLDER PASTE EXAMPLE

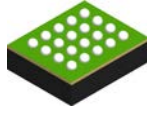
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 21  
78% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE  
SCALE:20X

4225320/A 09/2019

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

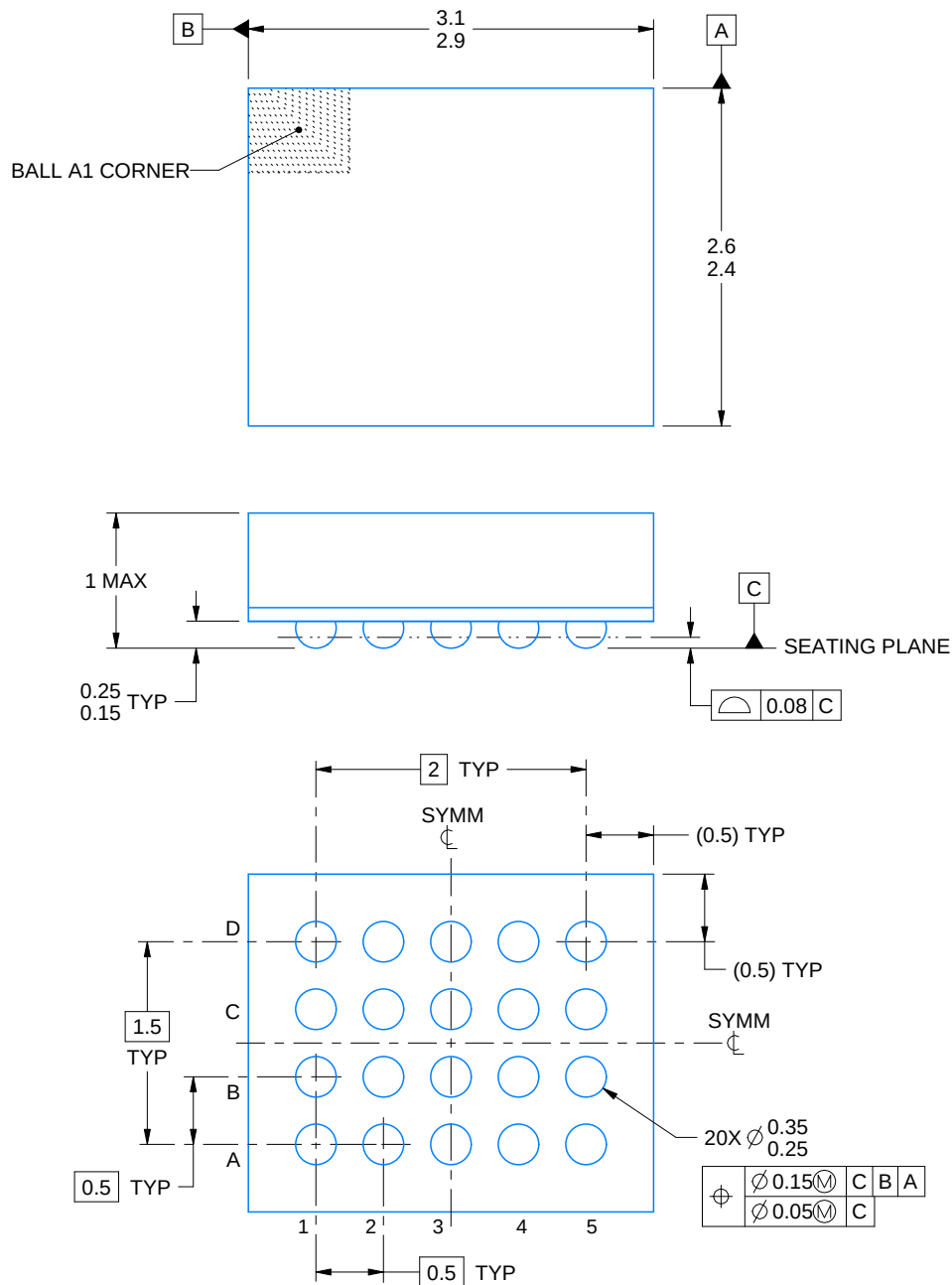


NME0020A

## PACKAGE OUTLINE

NFBGA - 1 mm max height

PLASTIC BALL GRID ARRAY



4224888/C 05/2023

### NOTES:

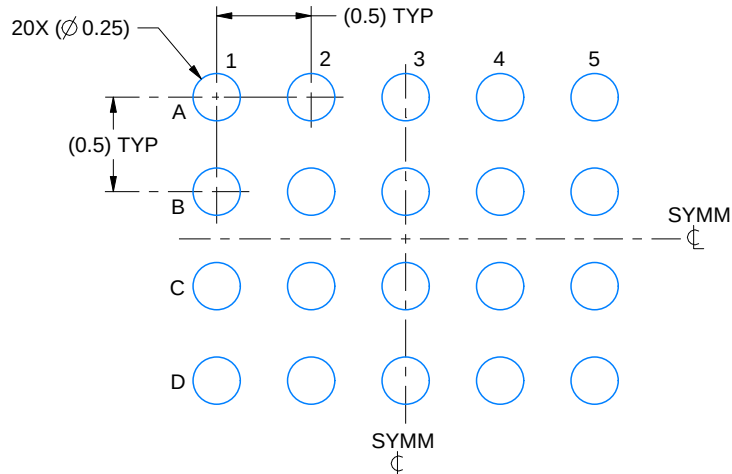
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

# EXAMPLE BOARD LAYOUT

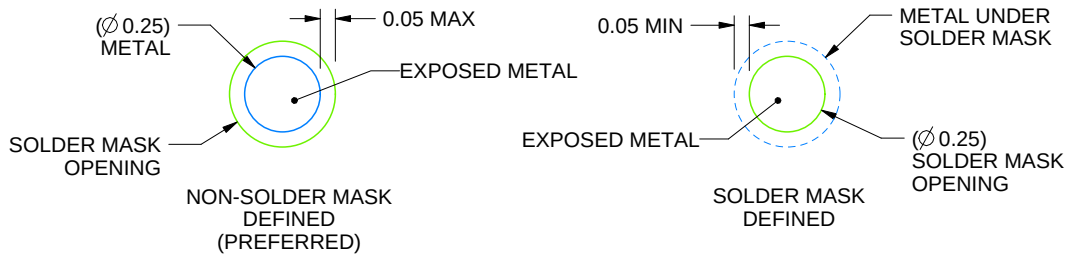
NME0020A

NFBGA - 1 mm max height

PLASTIC BALL GRID ARRAY



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:25X

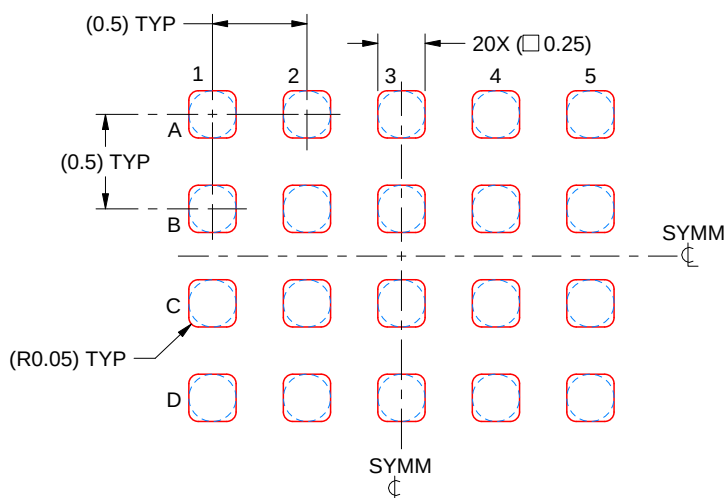


SOLDER MASK DETAILS  
NOT TO SCALE

4224888/C 05/2023

NOTES: (continued)

- Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For information, see Texas Instruments literature number SPRAA99 ([www.ti.com/lit/spraa99](http://www.ti.com/lit/spraa99)).



SOLDER PASTE EXAMPLE  
 BASED ON 0.1 mm THICK STENCIL  
 SCALE: 25X

4224888/C 05/2023

NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.

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